

Course B: rf technology  
Normal conducting rf  
Part 3: Linear Collider Hardware

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Eighth International Accelerator School for Linear Colliders  
Antalya, Turkey  
7 to 10 December 2013

We will now step back from theory and have a look at specific CLIC hardware.

We have already covered a lot of the theory although there is some more to come.

Still it is a good moment to look at real objects to give a context for all the abstract ideas that you have been seeing.

We will cover:

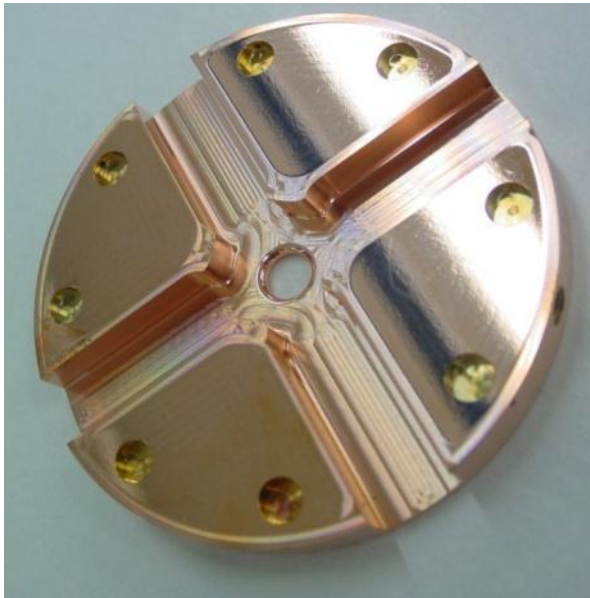
1. Accelerating structures
2. Two-beam concept
3. PETS (power generating) structures
4. A little bit about alignment and stabilization

This section will be basically a seminar on the CLIC rf system.

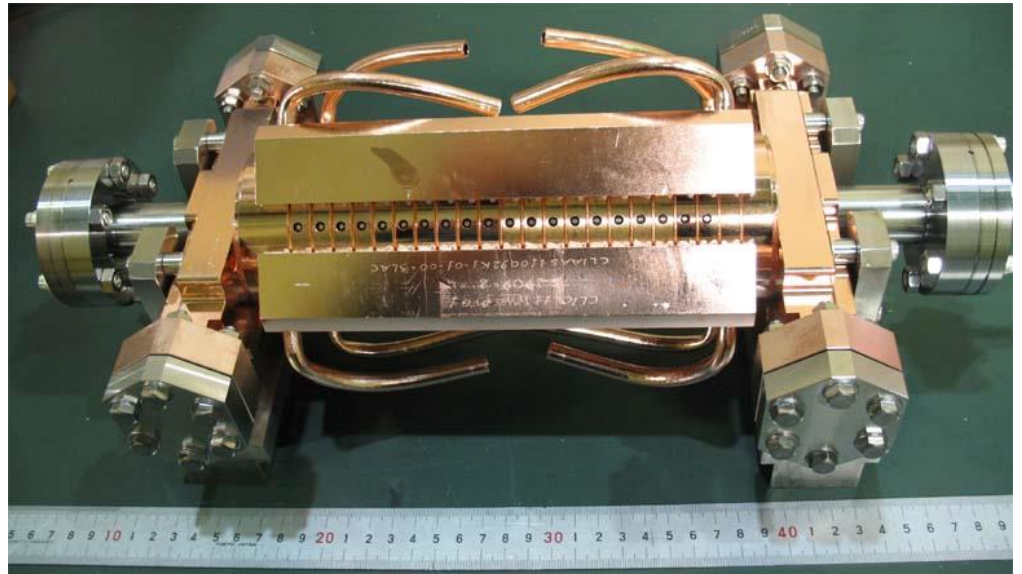
# The CLIC accelerating structure

Now that you have a feeling for the basic mechanisms which underlie high-efficiency acceleration, we will look into the main features of the CLIC rf system.

Let's start by looking at the CLIC accelerating structure:



The basic component: diamond turned and milled disk. We form a periodic structure by stacking them. The radial lines are damping waveguides



An assembled high-power test structure. Made in a collaboration between CERN, KEK and SLAC.

## High-gradient:

1. 100 MV/m loaded gradient
2. 156 (flat top)/240 (full) ns pulse length
3. Less than  $3 \times 10^{-7}$  breakdowns/pulse/m

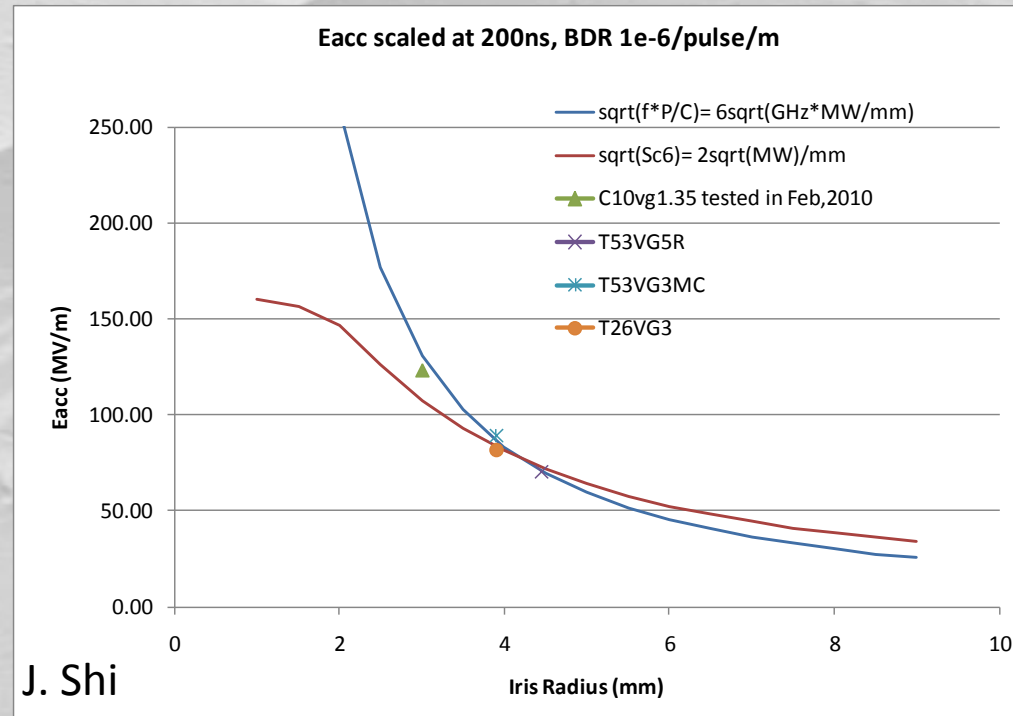
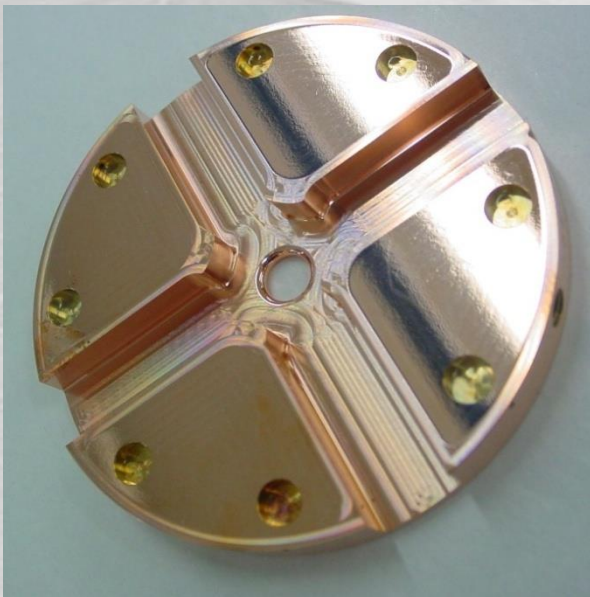
we observe the interrelation

$$BDR \propto E^{30} \tau^5$$

## Beam dynamics:

1. 5.8 mm diameter minimum average aperture (short range transverse wake)
2.  $< 1$  V/pC/mm/m long-range transverse wakefield at second bunch (approximately x50 suppression).

$$W_t \propto a^3 \quad \text{but}$$



# Accelerating structure characteristics

Operating frequency: 11.994 GHz



$\lambda$  free space is 25 mm

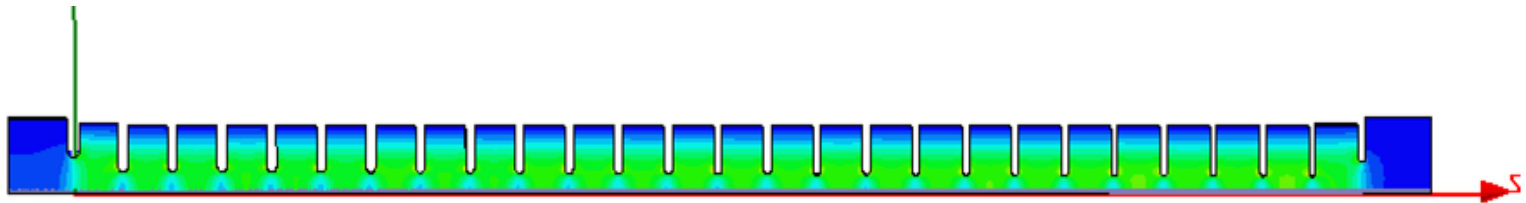
Operating phase advance:  $2\pi/3$



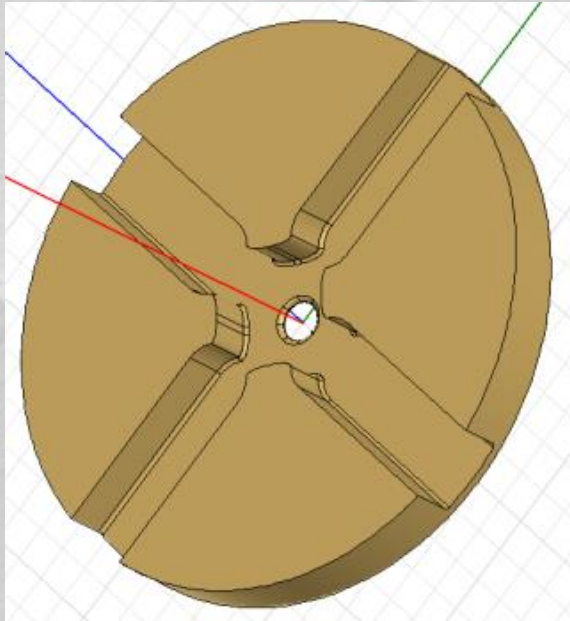
Active length: 230 mm

Number of cells: 26+2

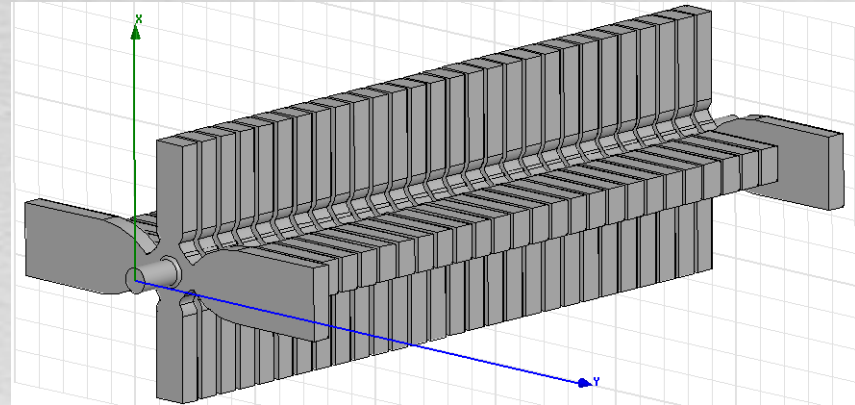
CLIC structures are tapered, for reasons of high-gradient performance and wakefield suppression which we will discuss later.



Power flow and beam direction

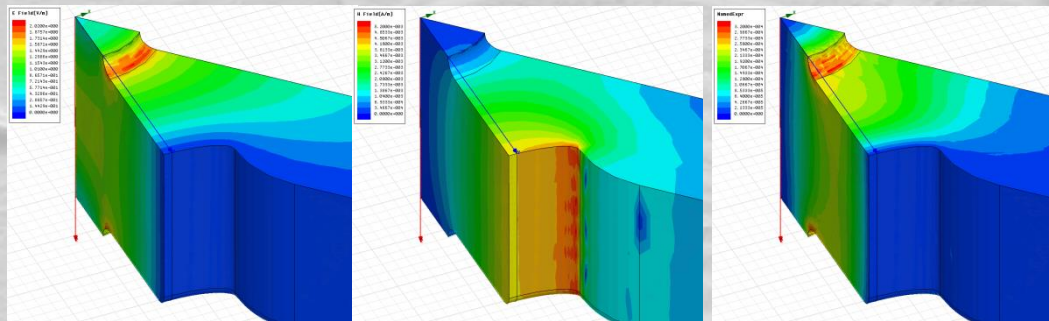


$$E_s/E_a$$



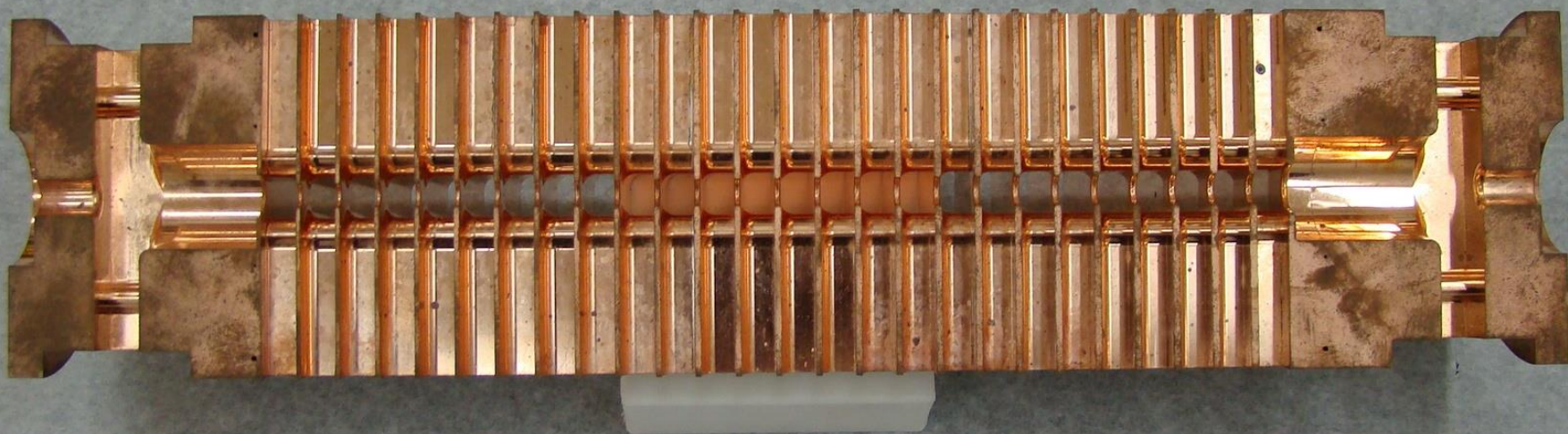
$$H_s/E_a$$

$$S_c/E_a^2$$





How it looks



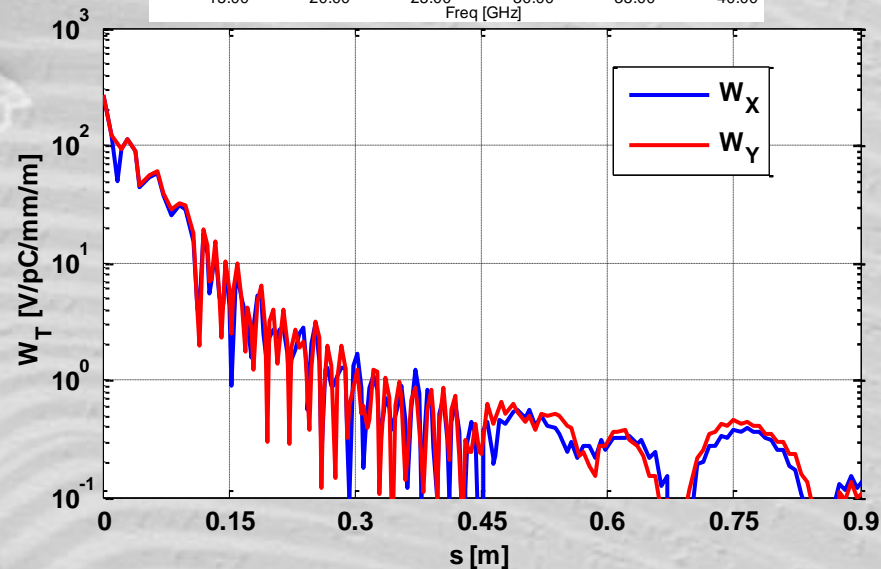
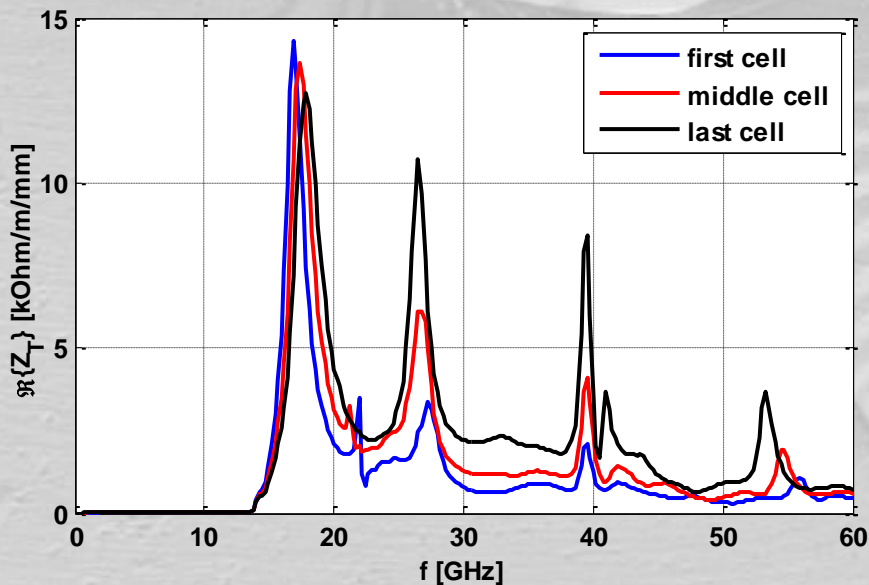
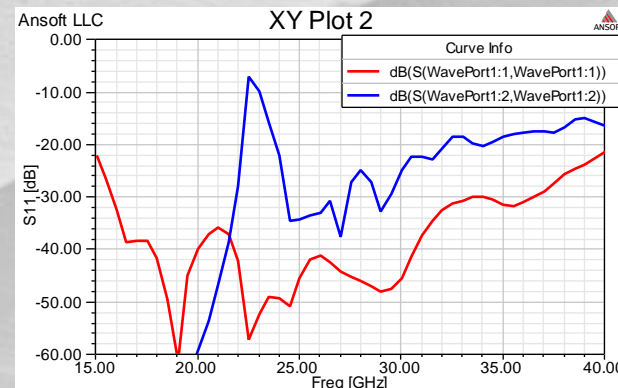
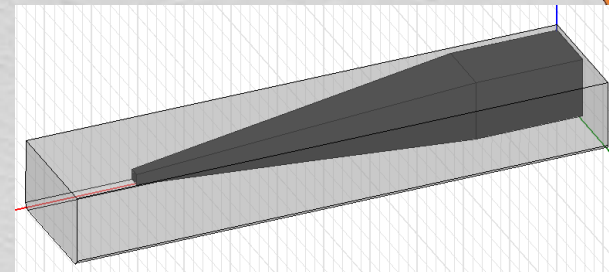




# Higher-order mode damping



Cell	First	Middle	Last
$Q$ -factor	11.1	8.7	7.1
Amplitude [V/pC/mm/m]	125	156	182
Frequency [GHz]	16.91	17.35	17.80

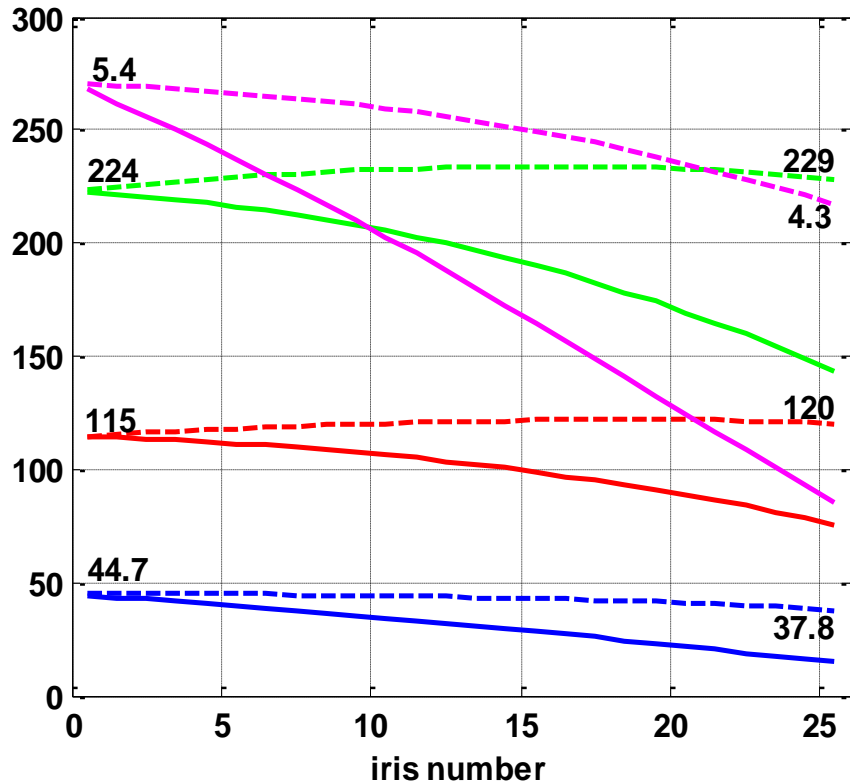


## Accelerating structure characteristics cont.

The aperture radii range from 3.15 to 2.35 mm with iris thicknesses of 1.67 to 1.00 mm.  
The resulting rf parameters are:

	first	last
$v_g$ [%c]	1.65	0.83
$R'/Q$ [k $\Omega$ /m]	14.6	17.9
$Q$	5536	5738
$R'$ [M $\Omega$ /m]	81	103

# Whole structure properties



The fundamental mode properties are shown in the regular cells.

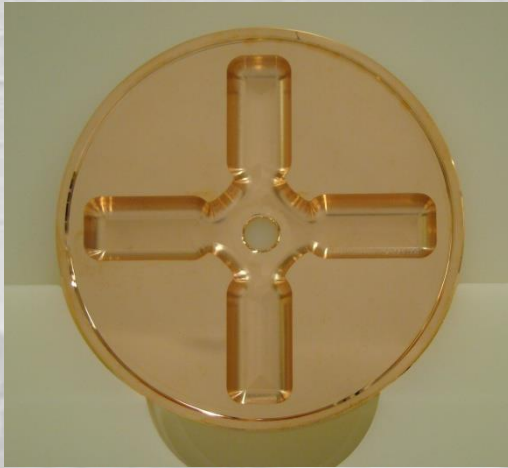
The traces from top to bottom are:

- Sc-50 [ $W/\mu m^2$ ](pink),
- surface electric field [MV/m](green),
- **accelerating gradient [MV/m](red),**
- pulse surface temperature rise [K](blue).

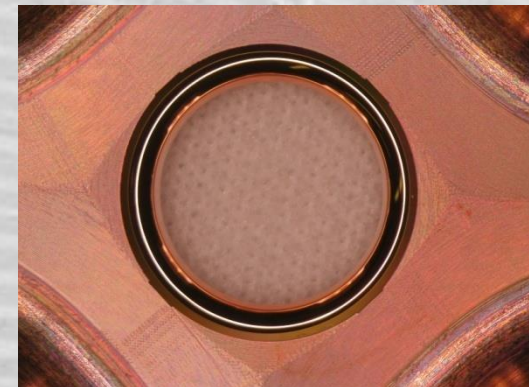
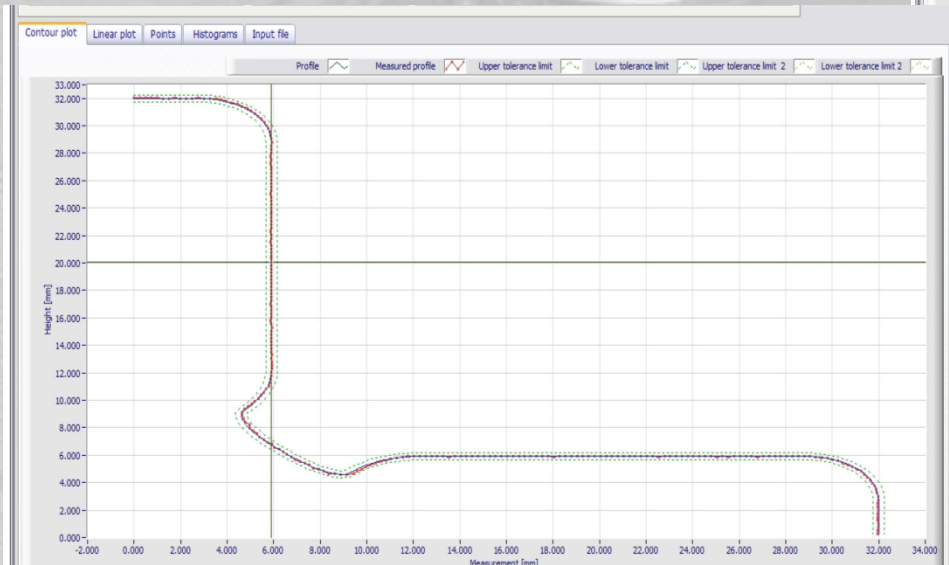
Dashed traces are unloaded and solid are beam loaded conditions.

# How to make 'em

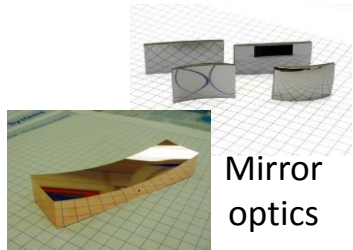
Machining: OFHC copper diamond milled and turned disks with micron precision.



**+ - 5 micron tolerance lines**



The market for micron precision parts has evolved over the last decades. Linear colliders are not alone.



Mirror optics



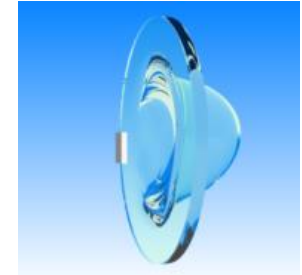
Optical recording



Injection molding of contact lenses



Imaging Optics



Freeform optics



Optical recording was the driving force to achieve higher accuracies

CD	DVD	Blu Ray
<p><math>\lambda = 780 \text{ nm}</math> <math>NA = 0.45</math></p> <p>1.2 mm substrate</p>	<p><math>\lambda = 650 \text{ nm}</math> <math>NA = 0.6</math></p> <p>0.6 mm substrate</p>	<p><math>\lambda = 400 \text{ nm}</math> <math>NA = 0.85</math></p> <p>0.1 mm cover layer</p>
<p>1.6 <math>\mu\text{m}</math></p>	<p>0.74 <math>\mu\text{m}</math></p>	<p>0.52 <math>\mu\text{m}</math></p>

*Form accuracy: 150 nm  $\Leftrightarrow$  50 nm*

*Roughness Ra : 5 nm  $\Leftrightarrow$  2 nm*

# Evolution of machining capability

## Single point diamond turning

### Up to the 1980's

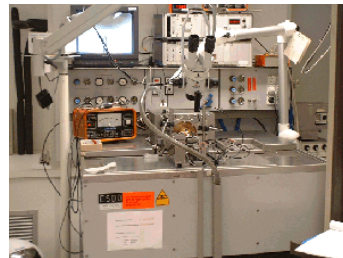
First machines at research institutes and universities



### 1980's - 1990's

Start of industrialization

- *Optical recording*
- *contact lenses*



### 2000's - 2010's

- *Larger machines*
- *Multiple axis ( X/Y/Z and C)*



### Future ?

- *Intelligent machines ?*
- *Robotisation ?*



## Ultra precision diamond milling (*lagging more than a decade behind on turning*)

### Up to the 1990's

Limited to fly cutting

- *mirror optics*
- *Laser scanner mirrors*



### 1990's - 2000's

Milling as add-on on lathes

- *Lens arrays*
- *Intra ocular lenses*



### 2010's

First proto type machines

- *Micro fluidics*
- *Accelerator parts*



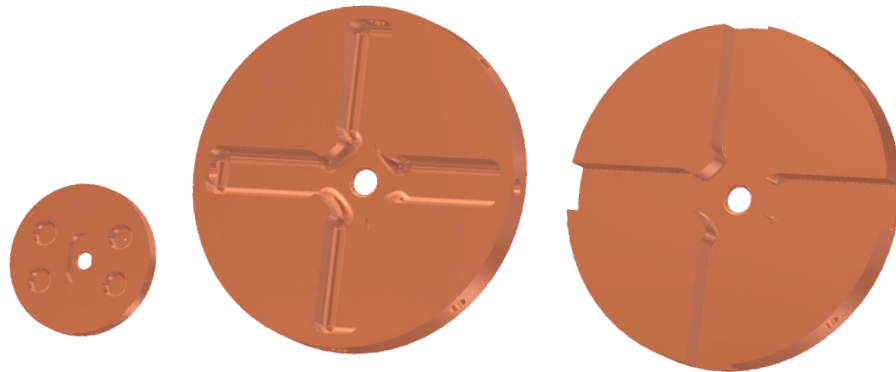
### Future ?

- *Pallet machining?*
- *Robotisation ?*



- BIGGER STRUCTURES, SAME TOLERANCES

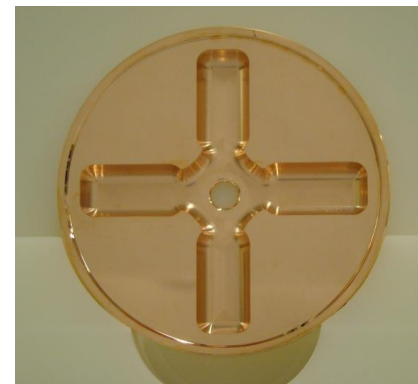
Started at  $\varnothing 35\text{mm}$  – now at  $\varnothing 80\text{mm}$  – in future up to  $\varnothing 200\text{mm}$  ?



- TIGHT ACCURACY SPECIFICATIONS FOR SERIES MANUFACTURING



**Moulds for DVD optics :**  
*50 nm form accuracy on  $\varnothing 2\text{ mm}$   
equals ratio of 1 / 40000*



**CLIC disk -> series part**  
*2  $\mu\text{m}$  accuracy on  $\varnothing 80\text{ mm}$   
equals ratio of 1 / 40000*

# High accurate Machining

## 5-axis CNC turning milling machine

### *Technical characteristics:*

X axis travel **350 mm**

Y axis travel **150 mm**

Z axis travel **300 mm**

B and C axis travel **360 degrees**

Swing capacity up to 20"

Air bearing Turning spindle 10,000 rpm

Air bearing Milling spindle 60,000 rpm

### *Precision*

**34 picometers** resolution rules (0.034 nanometers)

Incremental programming **0.01 nanometer**

Axial and radial spindle error  $\leq$  **25 nanometers**

B axis axial and radial error  $\leq$  **100 nanometers**

Shape defect  $\leq$  **0.15  $\mu\text{m}$**  on diameter 75 mm

Surface finish  $R_a \leq$  **3.0 nanometers**



**Machine delivered on january 2011  
First structure TD24WFM delivered on  
novembre 2011.**

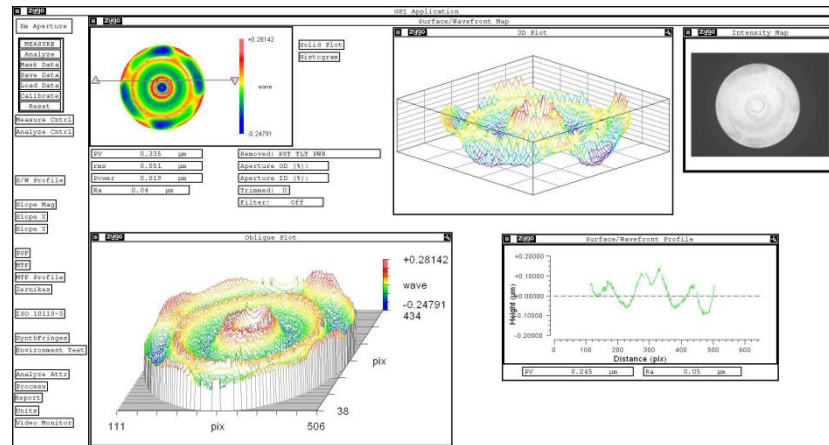


## Aluminum mirror for satellite application on its support delivery



### Results :

PV = 0.335  $\mu\text{m}$   
 Ra = 0.001  $\mu\text{m}$   
 RmS = 1,92 nm

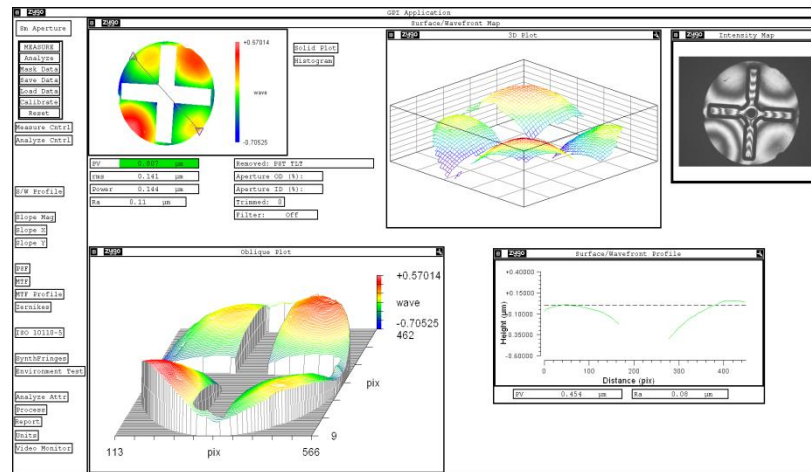


## Copper disk - accelerating structure

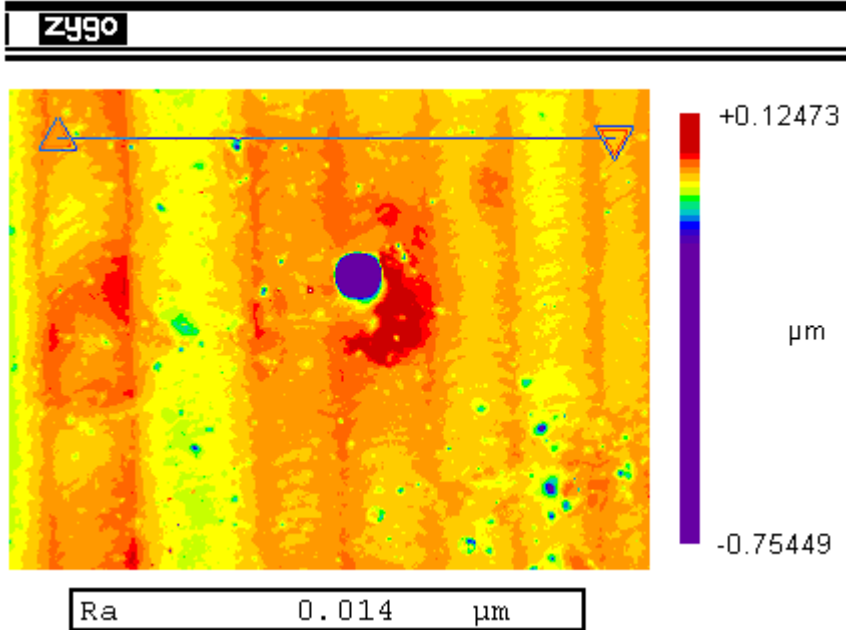


### Results :

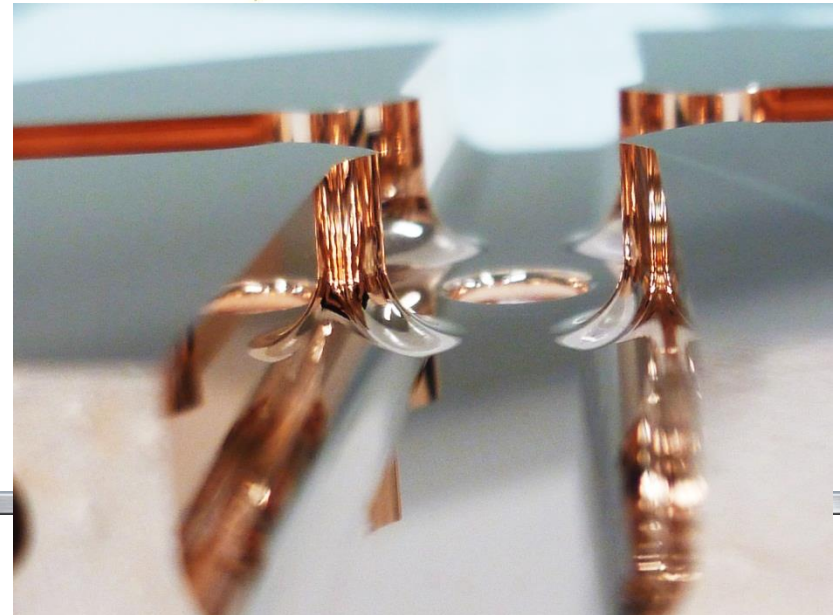
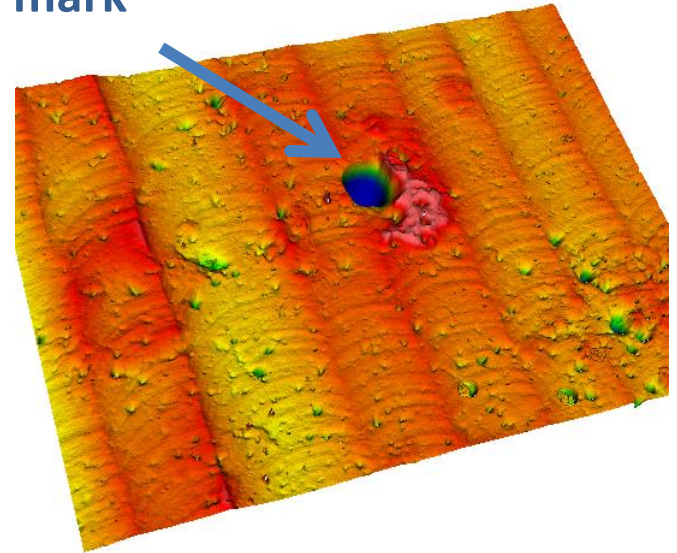
PV = 0.807  $\mu\text{m}$   
 Ra = 0.002  $\mu\text{m}$   
 RmS = 1,72 nm



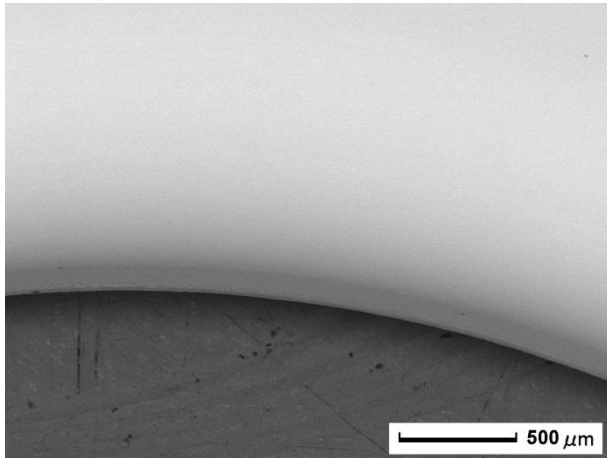
## Results



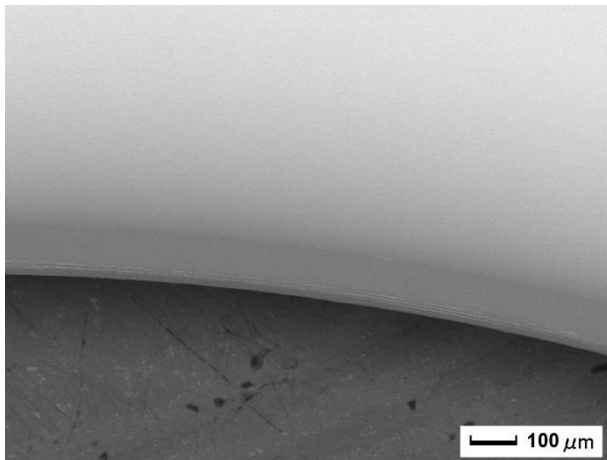
Métrology mark



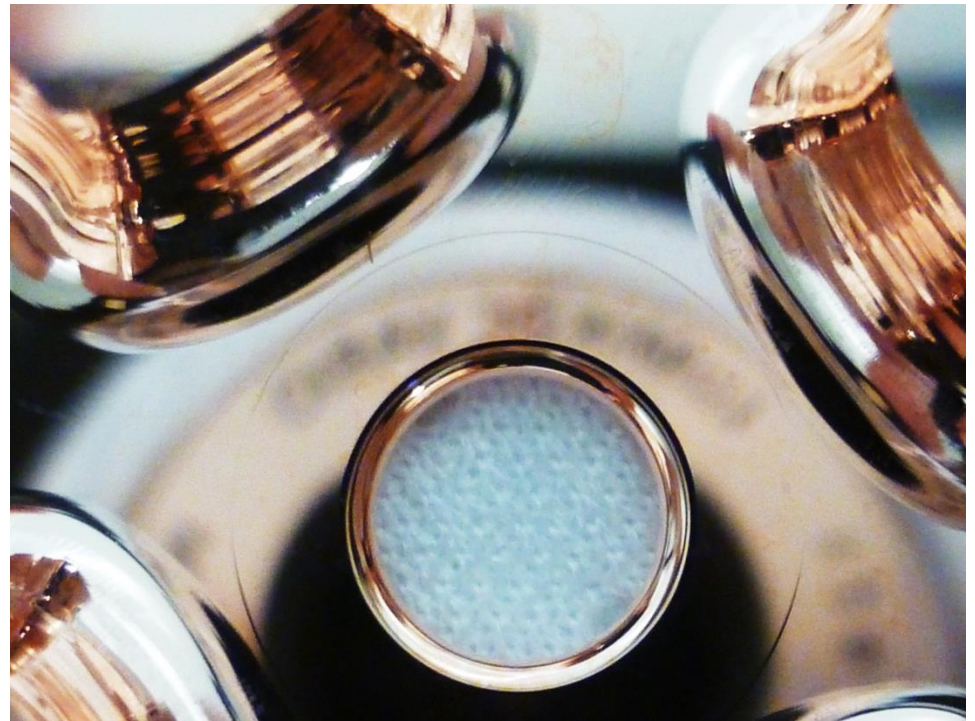
# Iris machining



**Ra between 2nm to 5nm**



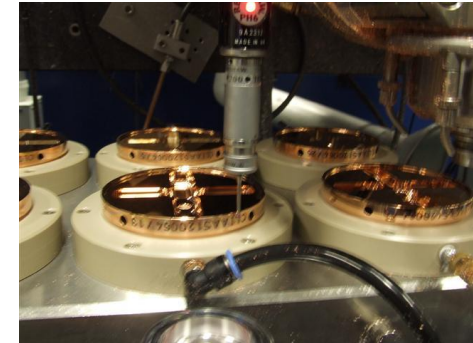
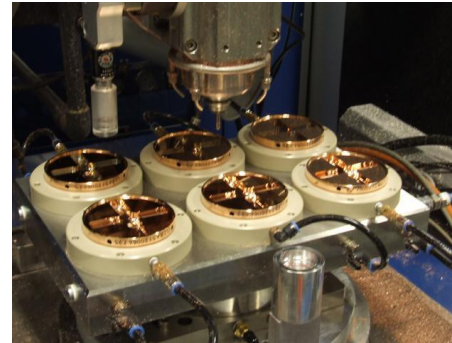
The machining of the iris start from diameter 20mm to erase milling perturbation in the center.  
The height of the step is about 1μ.



# VDL ETG Industry Commitment

- Investments in new skills

- H2 bonding
- Micro milling
- Pallet machining
- On machine metrology

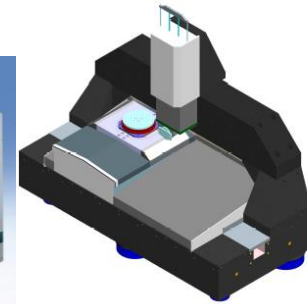


- Investments in people

- Cooperation programs with schools, universities, institutes
- Internal education
- Career paths

- Investments in infrastructure

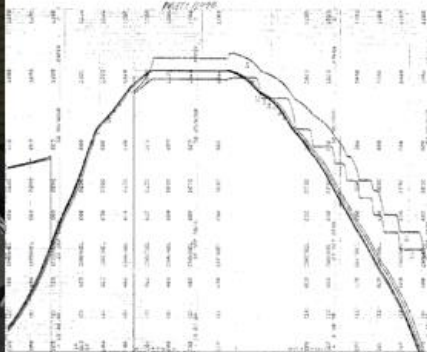
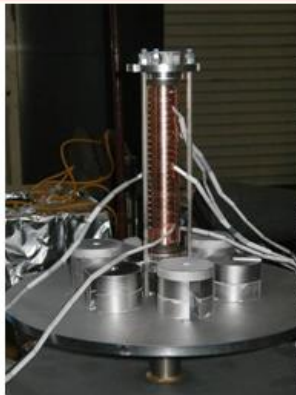
- Equipment
- New Facility



- **Guidance is required to steer investments in the right direction**



## Diffusion Bonding of T18\_vg2.4\_DISC

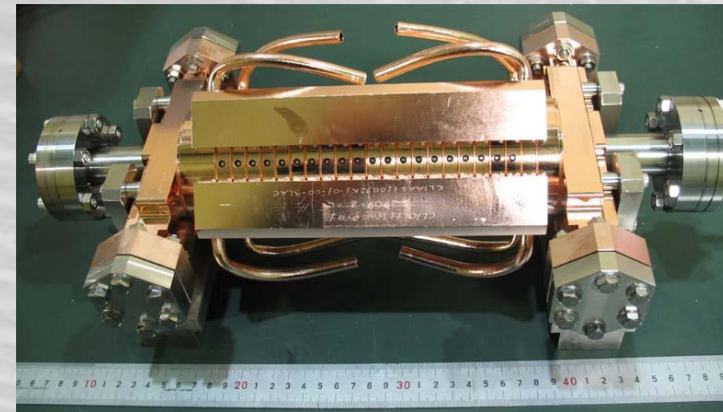
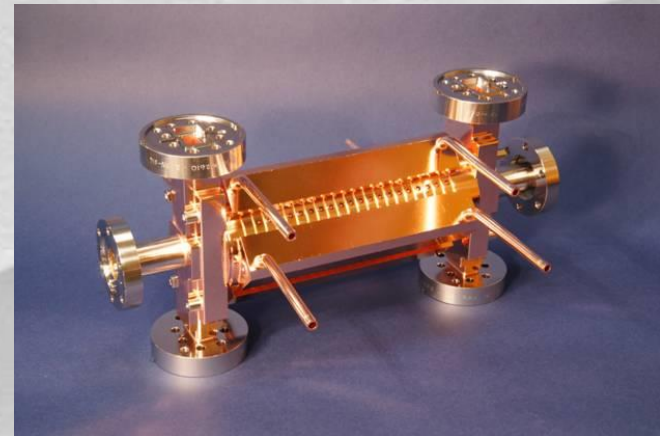


Pressure: 60 PSI (60 LB for this structure disks)  
Holding for 1 hour at 1020°C

## Vacuum Baking of T18\_vg2.4\_DISC



650°C  
10 days



Stacking disks

Structures ready for test

Temperature treatment for high-gradient

Walter Wuensch

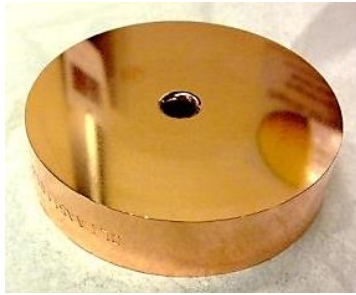
10 October 2011

- Done at Thales Electron Devices (TED) – Velizy (France)
- Degreasing and etching at CERN before bonding
- Applied weight: 43 kg equivalent to ~ 0.13 MPa; thermal cycle: flat top at 1035° C during 1h30
- Process validated on a test coupler: observation of crossing grains in the joint plan
- Some deformations observed on the outer faces after bonding : ~0.1 mm -> re-machining done

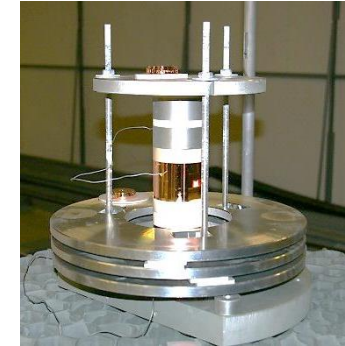
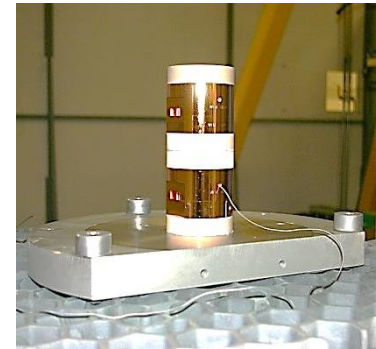
Coupler



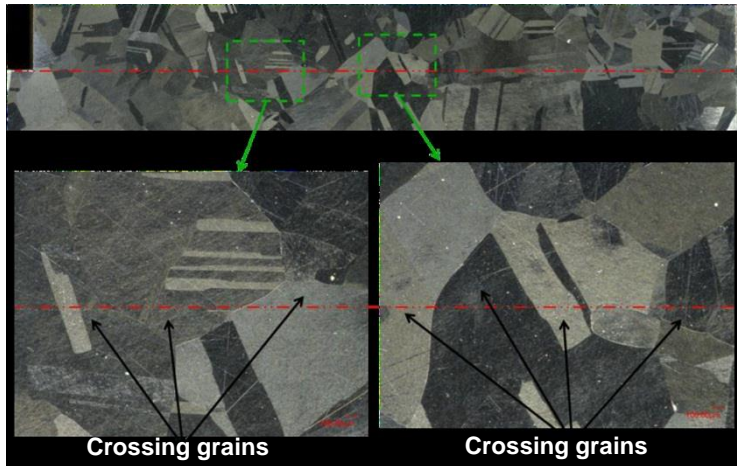
Extremity cell



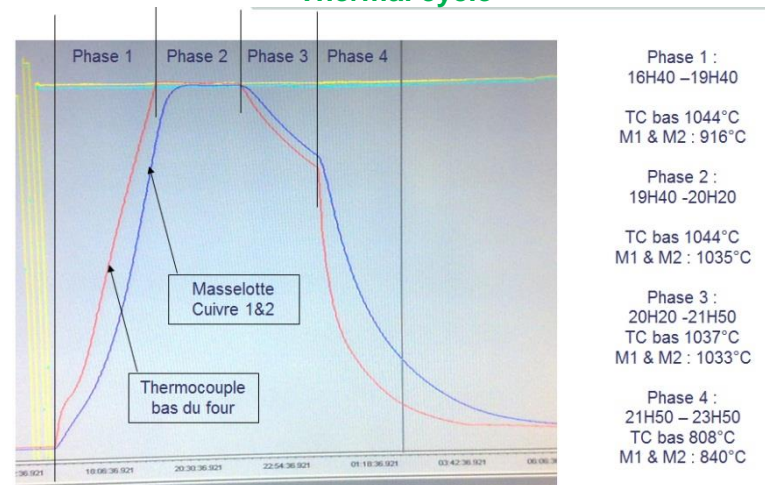
Assembly of couplers in the furnace



SEM observation of bonding plan after cutting

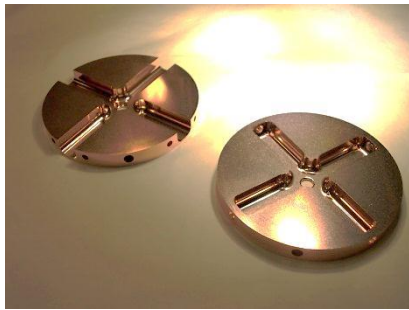


Thermal cycle

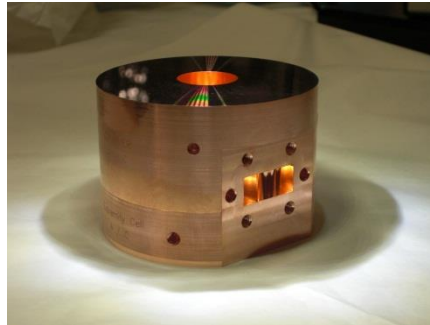


- Also done at TED with degreasing and etching at CERN before bonding
- Applied weight: 33.7 kg equivalent to ~ 0.08 – 0.12 MPa;
- Same thermal cycle as couplers but with flat top at 1010° C
- No deformations observed on the external diameter after bonding

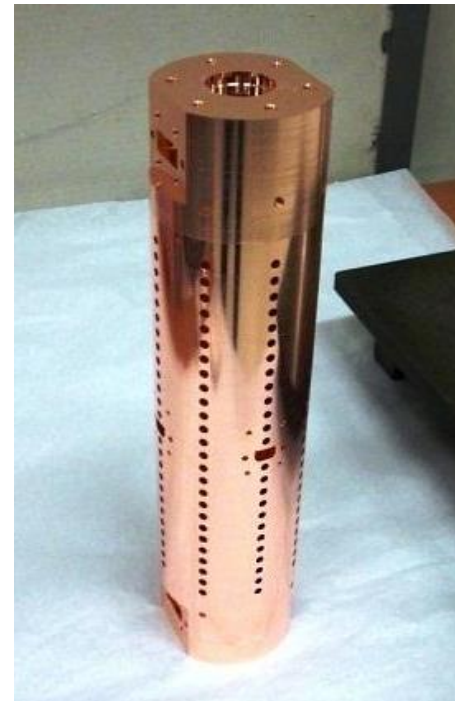
Disks after etching



Coupler



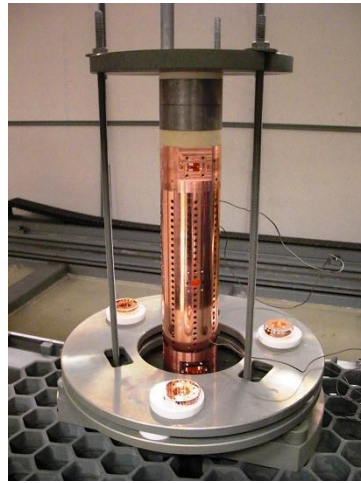
Structure n°1



Structure n°2



Assembly of disks in the furnace



## Geometrical measurements on external diameter after bonding

Alignment = 9µm for ACS#1 and 12.6 µm for ACS#2

Angle = 90.0514° for ACS#1 and 90.0087° for ACS#2

- Done at Bodycote – Villaz (France) and CERN
- Tuning studs and cooling circuits brazed with copper gold alloy below  $1000^{\circ}$  C under vacuum
- Good tightness and no drip of alloys observed in the cells
- Assembly test by screwing of WFM waveguides OK

Assembly of tuning studs

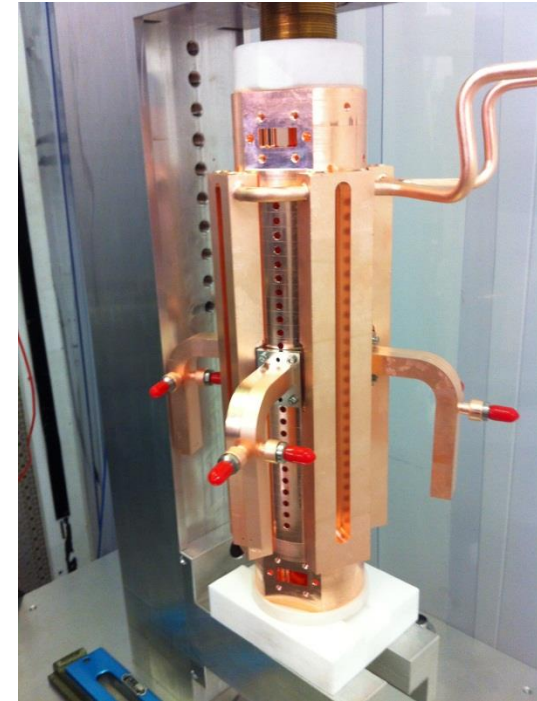


Assembly of cooling circuits



S. Lebet

Assembly of WFM waveguides





- Done at CERN by Jiaru Shi the 22th of Feb. 2012
- Target frequency: 11991.65 MHz (considering freq. shift due to wire, nitrogen and temperature of 21.6 deg)
- All disks tuned with only one stud used for each disk
- Very successful tuning

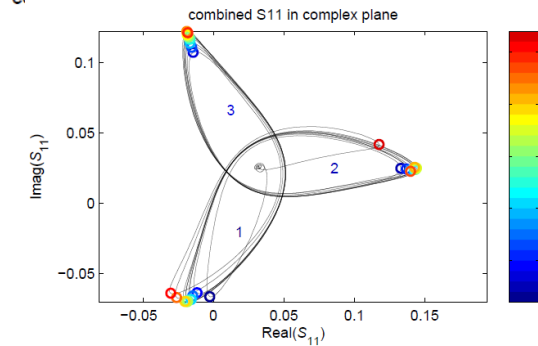
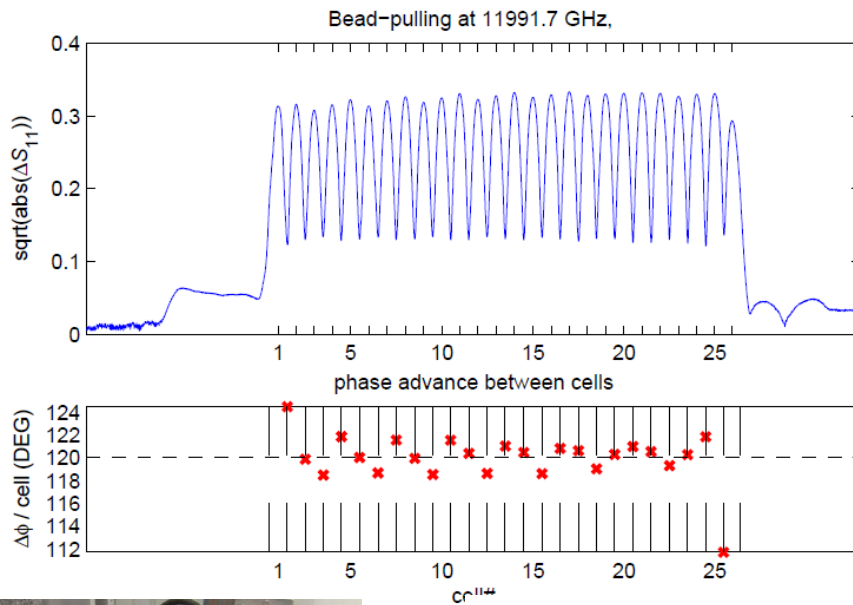


Figure 12: Bead-pulling at 11991.7 GHz

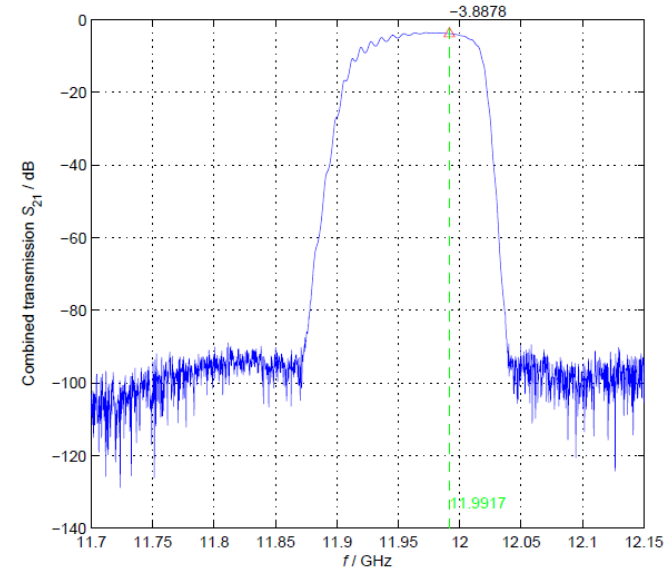


Figure 8: Combined transmission from input to output

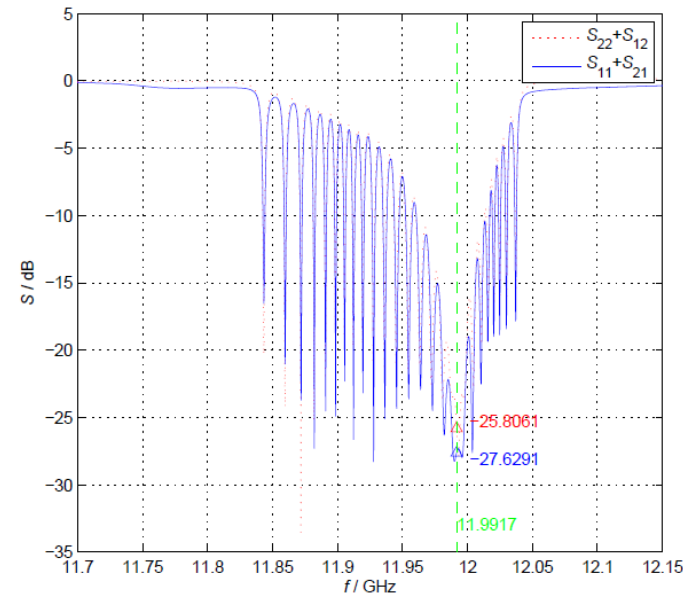
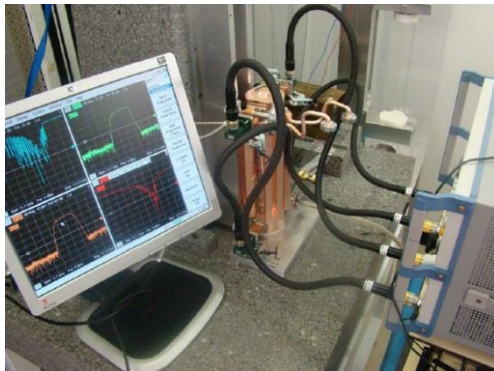
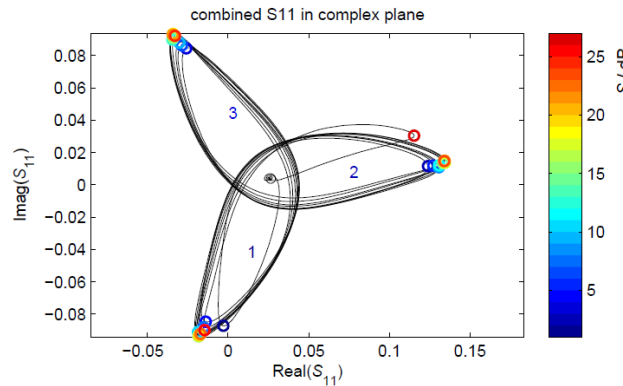
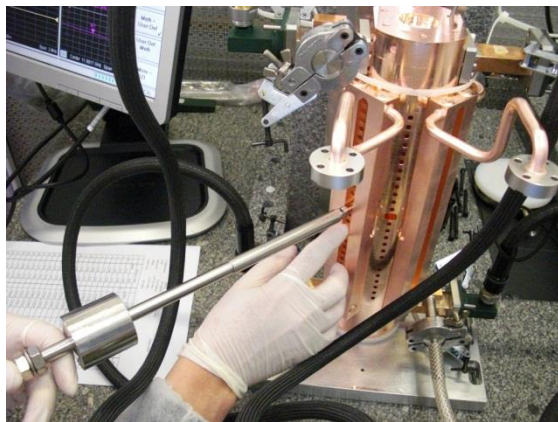
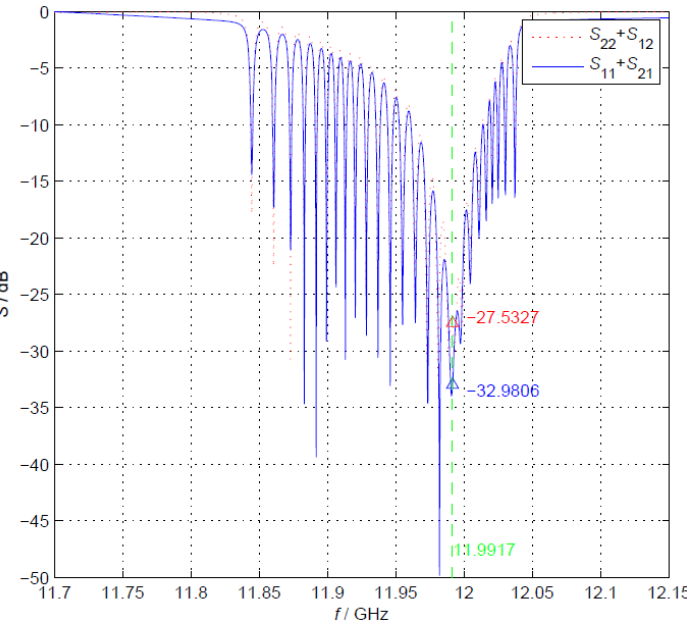
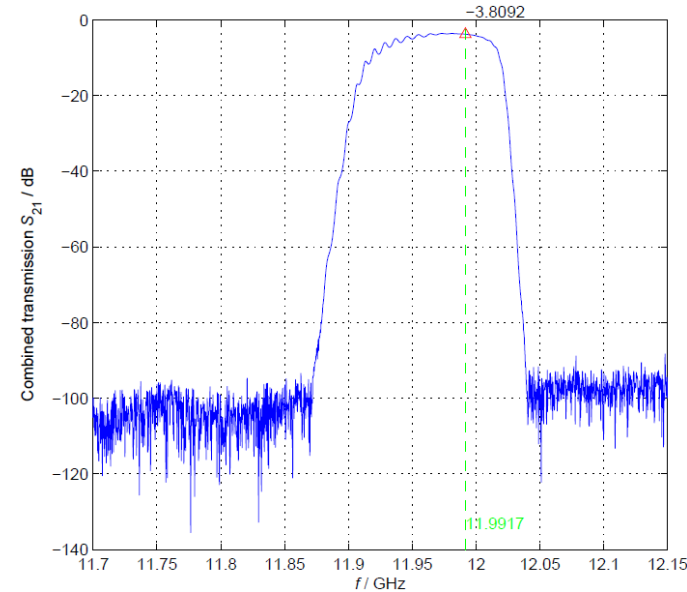
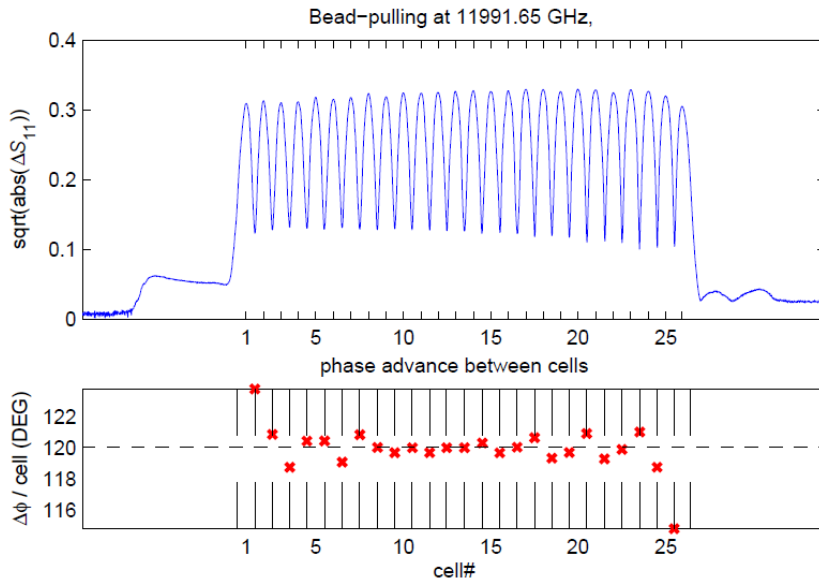
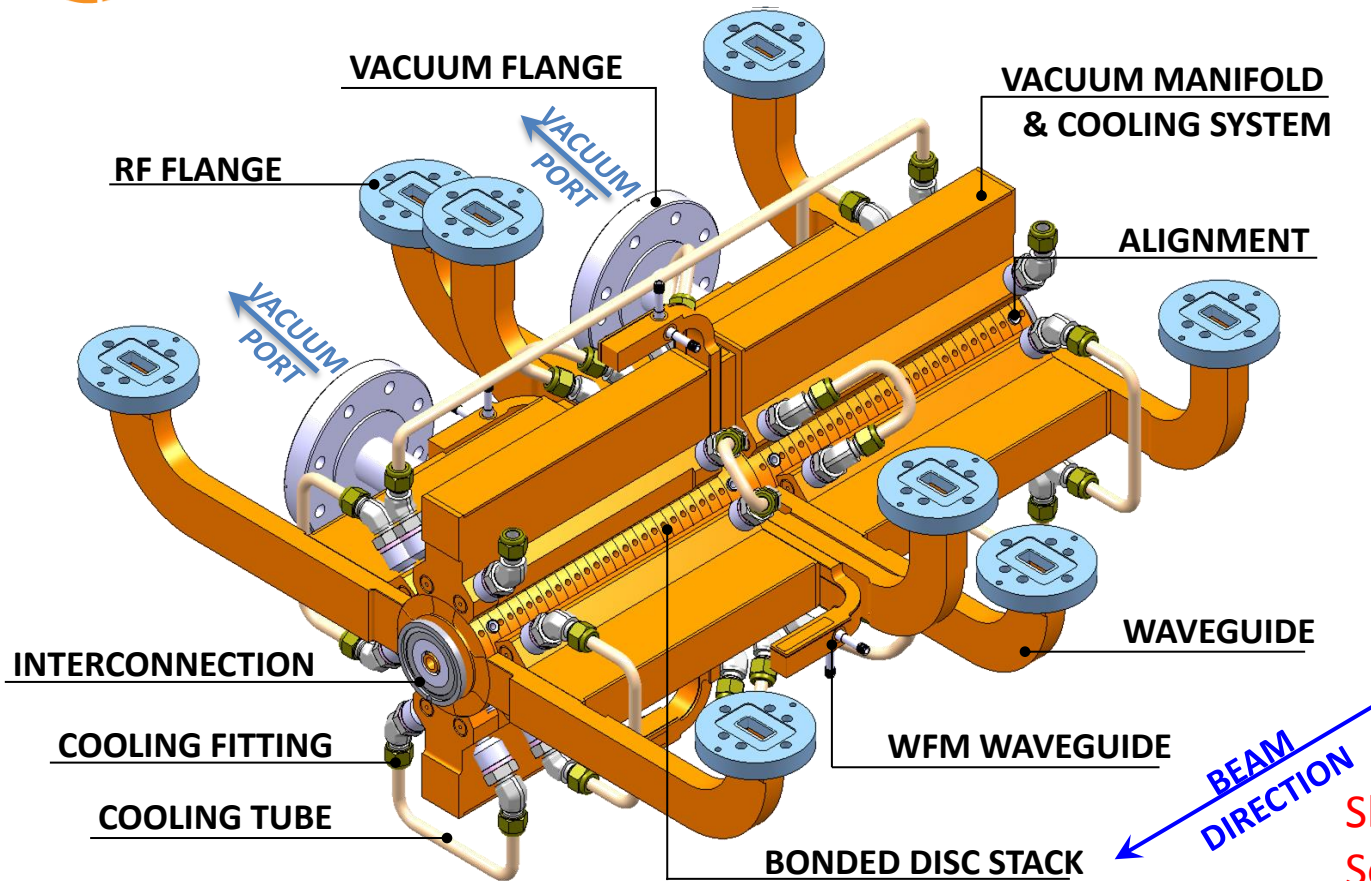


Figure 4: Reflection at input



- Same procedure as structure N1, done the 6<sup>th</sup> of March 2012
- Disk 13 tuned by -10 MHz (the 4 studs were used), all the other disks were tuned +/- 3MHz like structure N1
- Very successful tuning also





Slide from Anastasiya Solodko

- Compact coupler design (already in TD26 CC);
- The body of an AS formed by high-precision copper discs joint by diffusion bonding at 1040 °C;
- Two AS are brazed together to form a superstructure (SAS);
- The SAS has 8 vacuum manifolds and 4 Wakefield Monitor (WFM) waveguides;
- The cooling system is integrated into the vacuum manifolds in order to provide a more compact technical solution.



NLCTA at SLAC



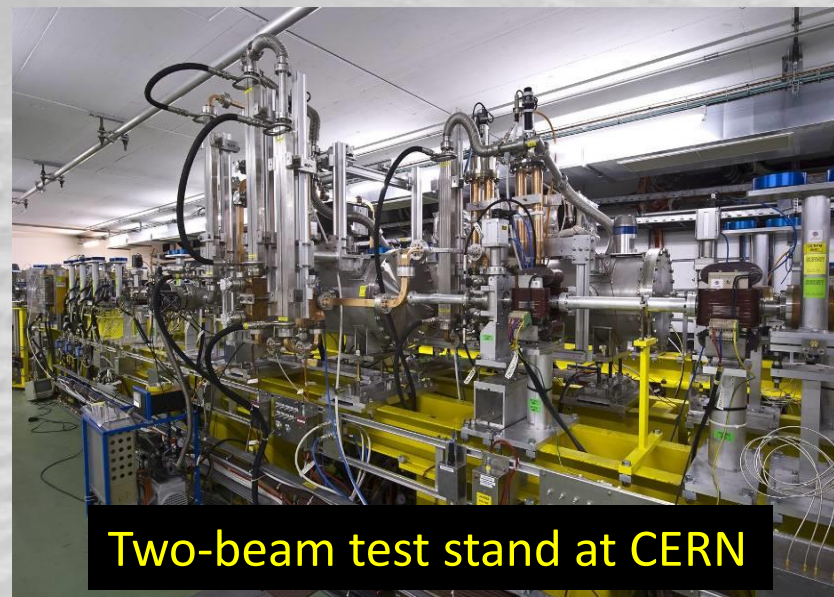
Nextef at KEK



New klystron at CERN



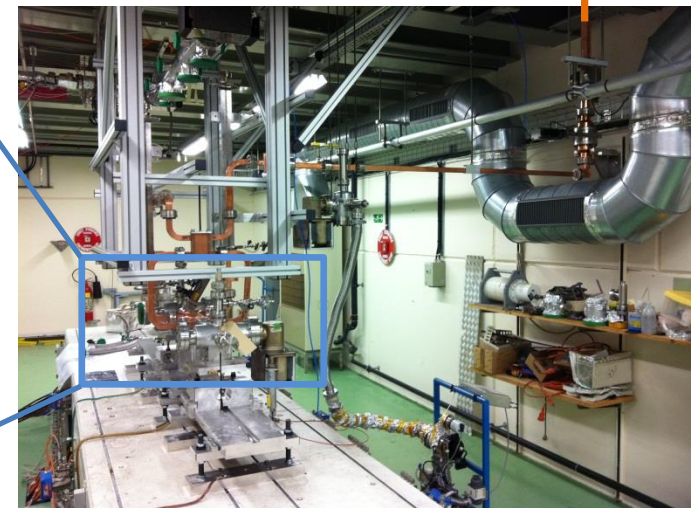
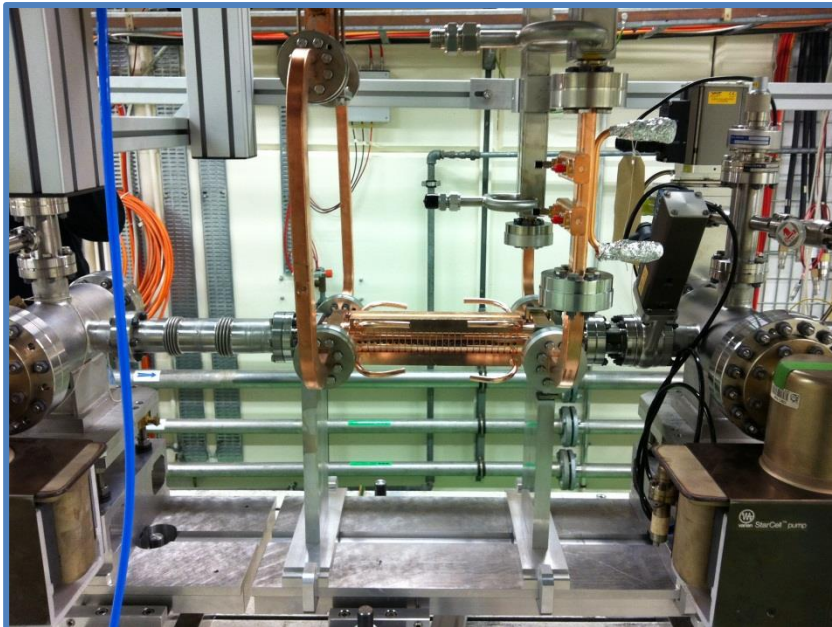
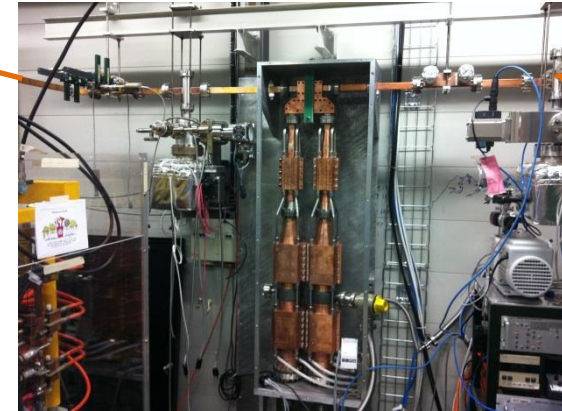
ASTA at SLAC



Two-beam test stand at CERN

## Status of the 12GHz standalone test stand

- WG network and LLRF finished
- Final vacuum infrastructure installation end of June
- Modulator flat top tuning by Scandionova done
- Klystron conditioned up to 40MW, 500ns, 50Hz with loads (50MW, 300ns, 50Hz)
- Pulse compressor operation started after FAT of modulator



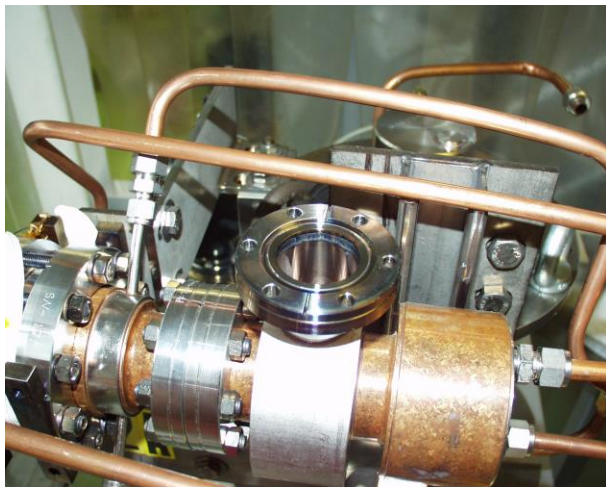
.....  
Gallery  
Bunker

# Klystron

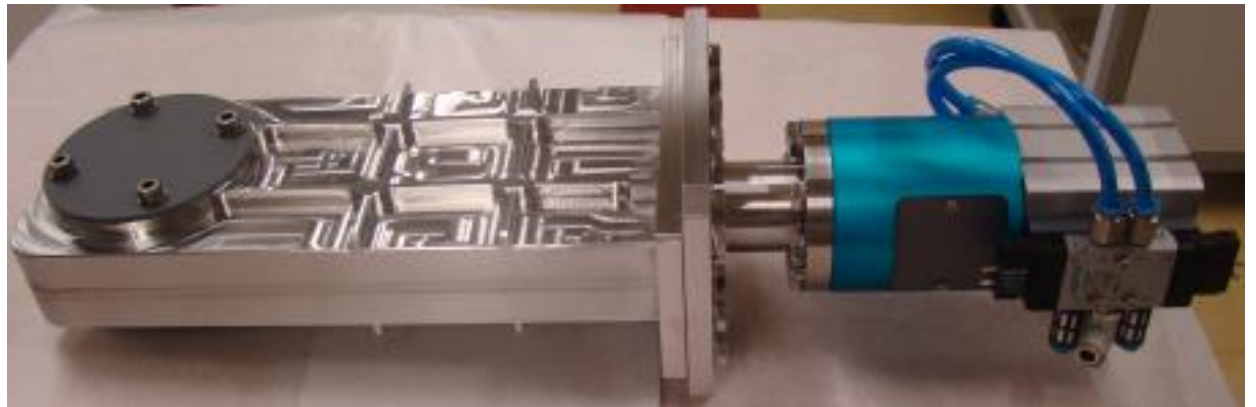


**XL5 klystron, a scaled version of the successful XL4 klystron developed at SLAC**

- Delivers 50MW, 1.5us long rf pulses with 50Hz repetition rate at 400kV, 300A, 600W rf drive power
- Working frequency 11.99424GHz
- Five klystrons built by SLAC
- Conditioned and tested at SLAC
  
- Extraordinary robust, survived a vacuum leak, a gun realignment and an overheating solenoid without any performance decrease so far...

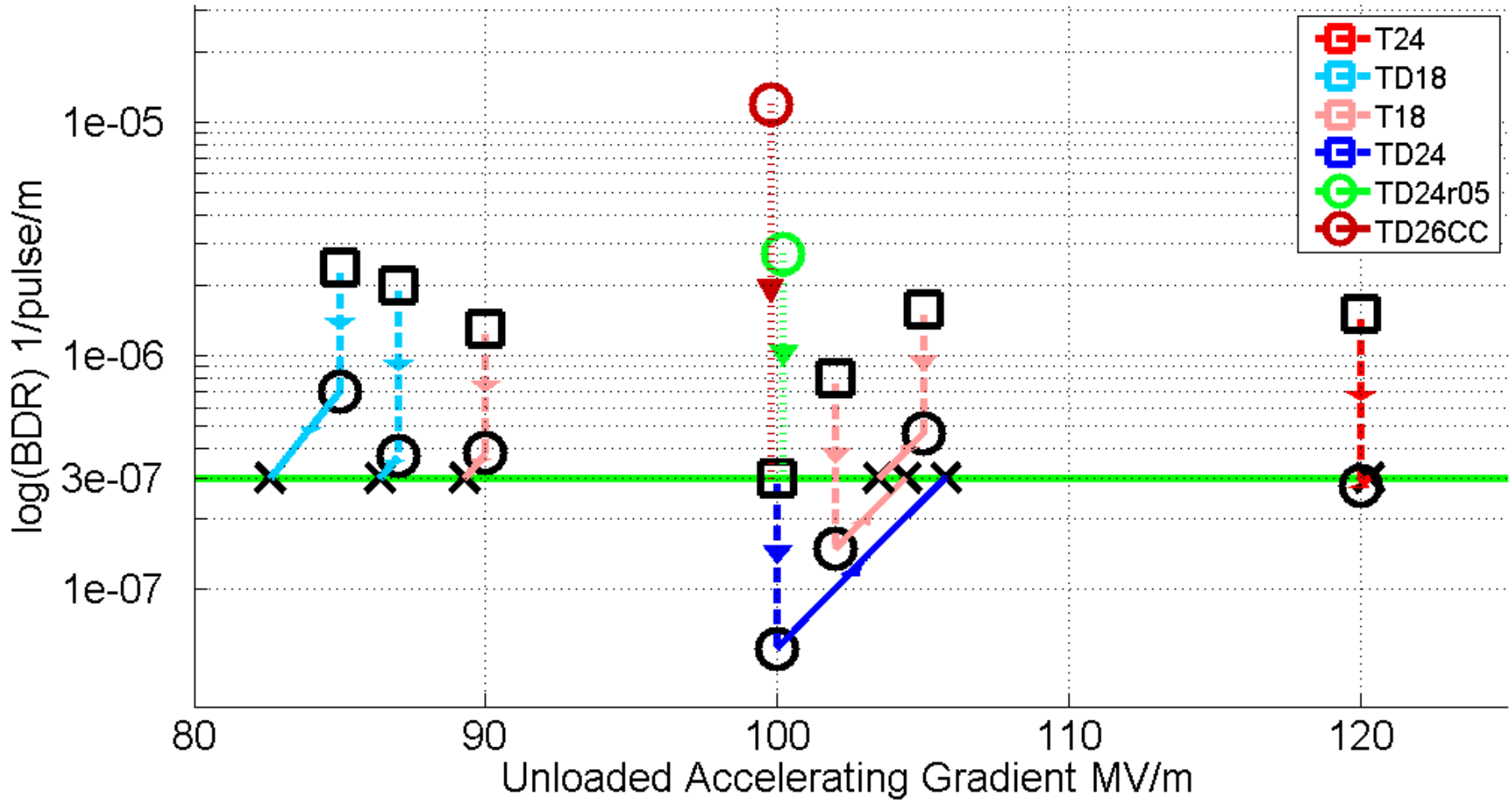


More details in: SLAC-PUB-14377



X-band RF components: PETS On-Off mechanism, compact pumping port, 60 dB directional coupler, vacuum gate valve

# CLIC structure performance summary

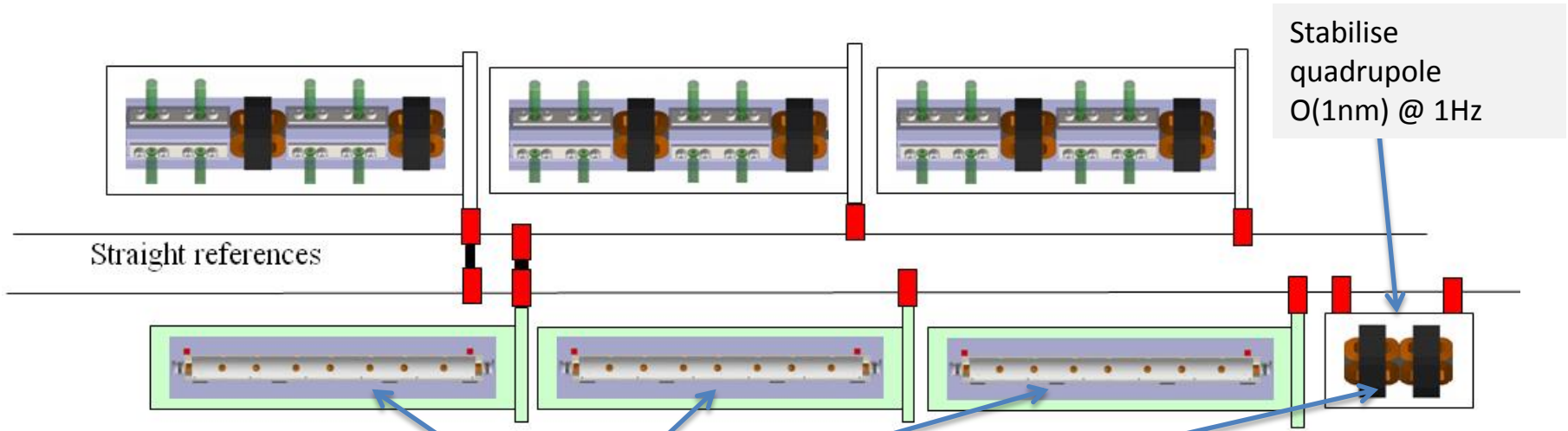




# Accelerating structure parameters

Average loaded accelerating gradient	100 MV/m
Frequency	12 GHz
RF phase advance per cell	$2\pi/3$ rad.
Average iris radius to wavelength ratio	0.11
Input, Output iris radii	3.15, 2.35 mm
Input, Output iris thickness	1.67, 1.00 mm
Input, Output group velocity	1.65, 0.83 % of $c$
First and last cell $Q$ -factor (Cu)	5536, 5738
First and last cell shunt impedance	81, 103 M $\Omega$ /m
Number of regular cells	26
Structure length including couplers	230 mm (active)
Bunch spacing	0.5 ns
Bunch population	$3.72 \times 10^9$
Number of bunches in the train	312
Filling time, rise time	67 ns, 21 ns
Total pulse length	243.7 ns
Peak input power	61.3 MW
RF-to-beam efficiency	28.5 %
Maximum surface electric field	230 MV/m
Maximum pulsed surface heating temperature rise	45 K

# Main Linac Tolerances



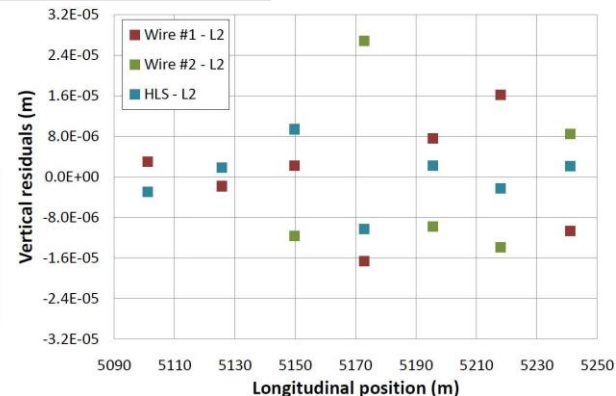
3) Use wake-field monitors  
accuracy O(3.5 $\mu$ m)

1) Pre-align BPMs+quads  
accuracy O(10 $\mu$ m) over about 200m

2) Beam-based alignment

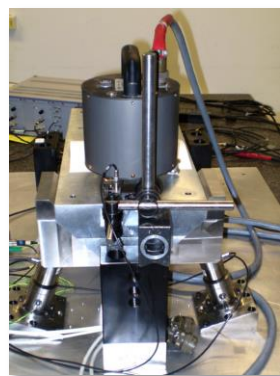
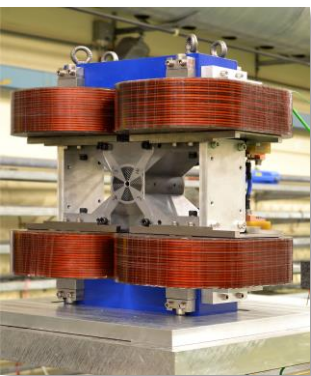


• Test of prototype shows  
 • vertical RMS error of 11 $\mu$ m  
 • i.e. accuracy is approx. 13.5 $\mu$ m

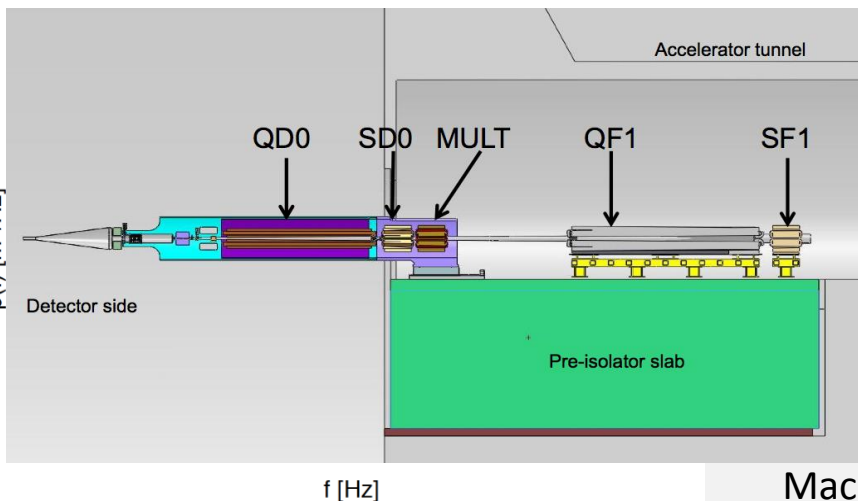
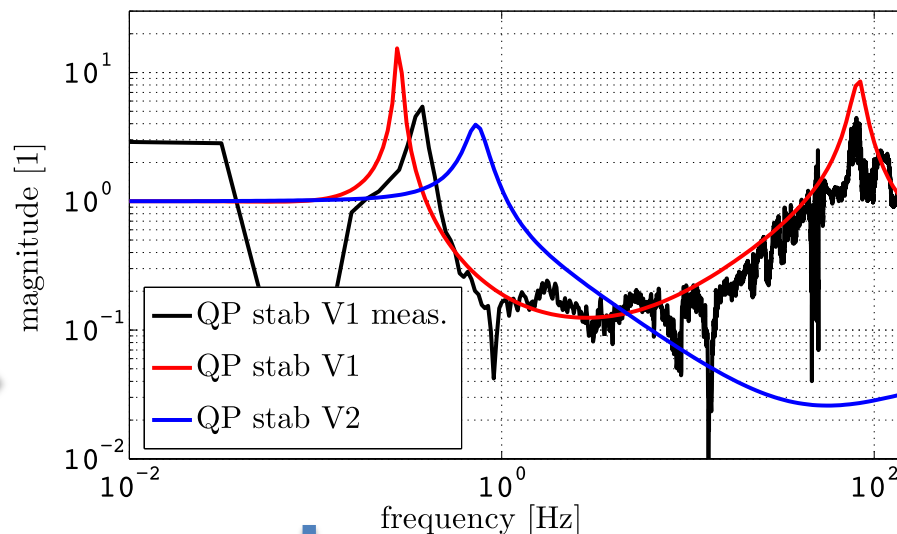


# Active Stabilization

Typical quadrupole jitter tolerance  
 $O(1\text{nm})$  in main linac and  $O(0.1\text{nm})$  in  
 final doublet



Final Focus QD0 Prototype



Code

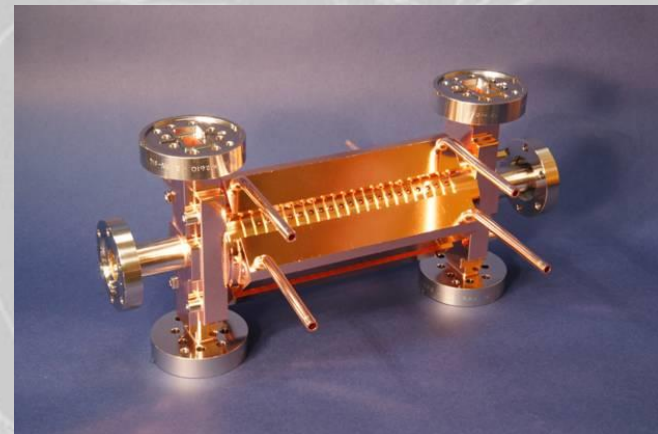
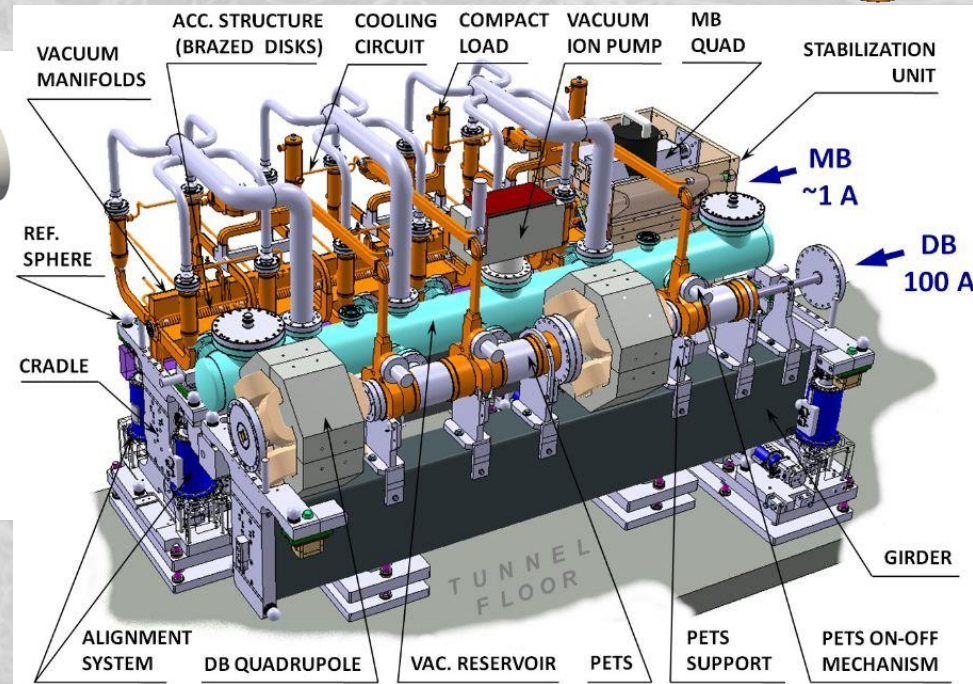
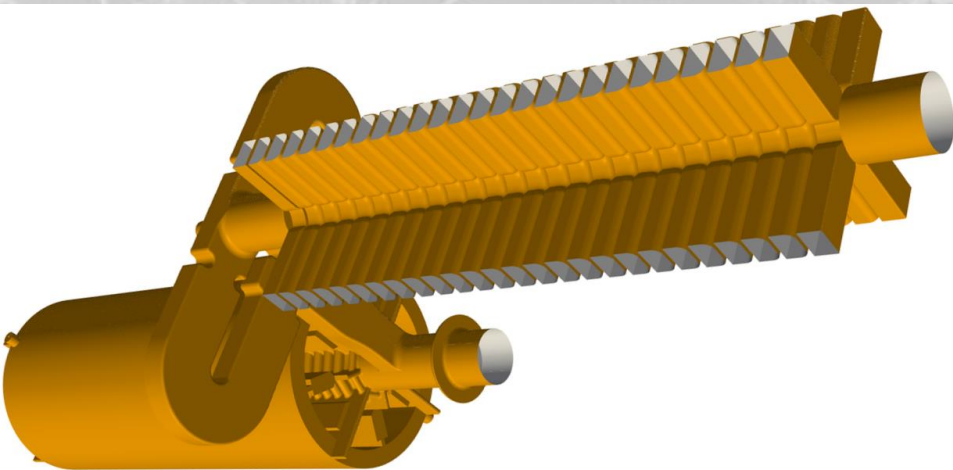
Machine model  
 Beam-based feedback

Luminosity **achieved/lost** [%]

	<b>B10</b>
No stab.	53%/68%
Current stab.	108%/13%
Future stab.	118%/3%

Close to/better  
 than target

# Elements of CLIC two-beam



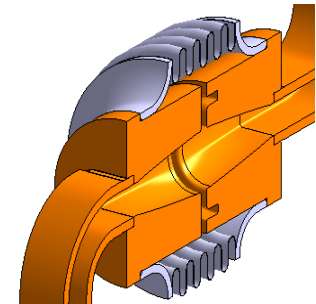


# Two-beam RF components

Waveguide network

- high power
- precise phase length

CHOKE-MODE FLANGE



Choke mode flange

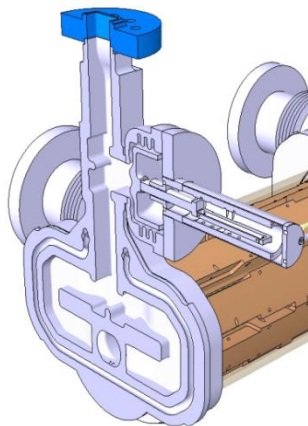
- independent alignment of main and drive beam

PETS

- high-power
- as short as possible
- low longitudinal and transverse impedance



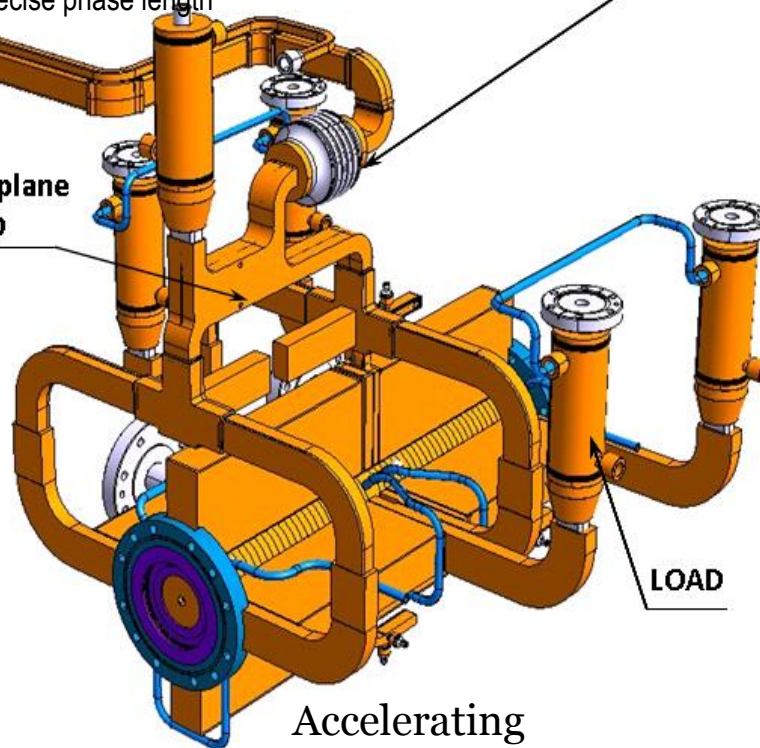
ON/OFF mechanism



On/ramp/off

- necessary (?) to react to breakdown and/or failure

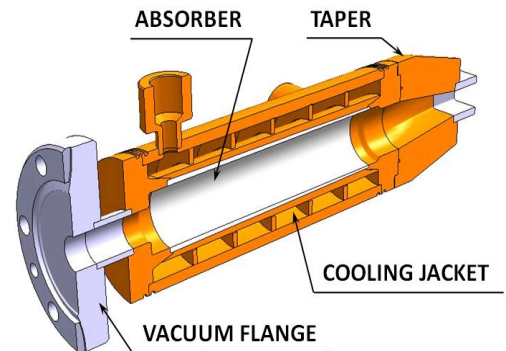
3 dB E-plane HYBRID



LOAD

Accelerating structure

- high-gradient
- as long as possible
- micron precision
- transverse wake-field suppression



ABSORBER

TAPER

COOLING JACKET

VACUUM FLANGE

# The early days of multi-TeV linear colliders

EUROPEAN ORGANIZATION FOR NUCLEAR RESEARCH

CERN-LEP-RF/86-06

and

CLIC NOTE 13  
13.2.86

A TWO-STAGE RF LINER COLLIDER  
USING A SUPERCONDUCTING DRIVE LINAC

M. Schnell

## Abstract

The efficiency from RF input to beam power of a normal conducting travelling-wave linac can be raised above 5% albeit at the price of a very short pulse and an appreciable but probably correctable energy spread. Compensated multibunch operation may yield 30% efficiency but higher order wakefield problems have to be solved and a suitable final focus system must be found. The worst remaining problem seems to be the economic and efficient generation of peak RF power. The solution proposed here consists of a limited number of MW UHF klystrons, a superconducting UHF drive linac and a tightly bunched drive beam of several GeV average energy, transferring energy from the superconducting linac to the main linac via short sections of transfer structures. The power balance of this scheme is analysed and it is found that overall efficiency can be very high. Very dense drive bunches are required. Present-day performance of superconducting cavities is already sufficient to make the scheme viable at main linac accelerating gradients approaching 100 MV/m.

Geneva, Switzerland  
February 1986

APR 7 1986  
ISLS LIBRARY

CLIC Note 38  
(May, 1987)

ORGANISATION EUROPÉENNE POUR LA RECHERCHE NUCLÉAIRE  
**CERN** EUROPEAN ORGANIZATION FOR NUCLEAR RESEARCH

REPORT FROM THE ADVISORY PANEL ON THE PROSPECTS  
FOR  $e^+e^-$  LINEAR COLLIDERS IN THE TeV RANGE

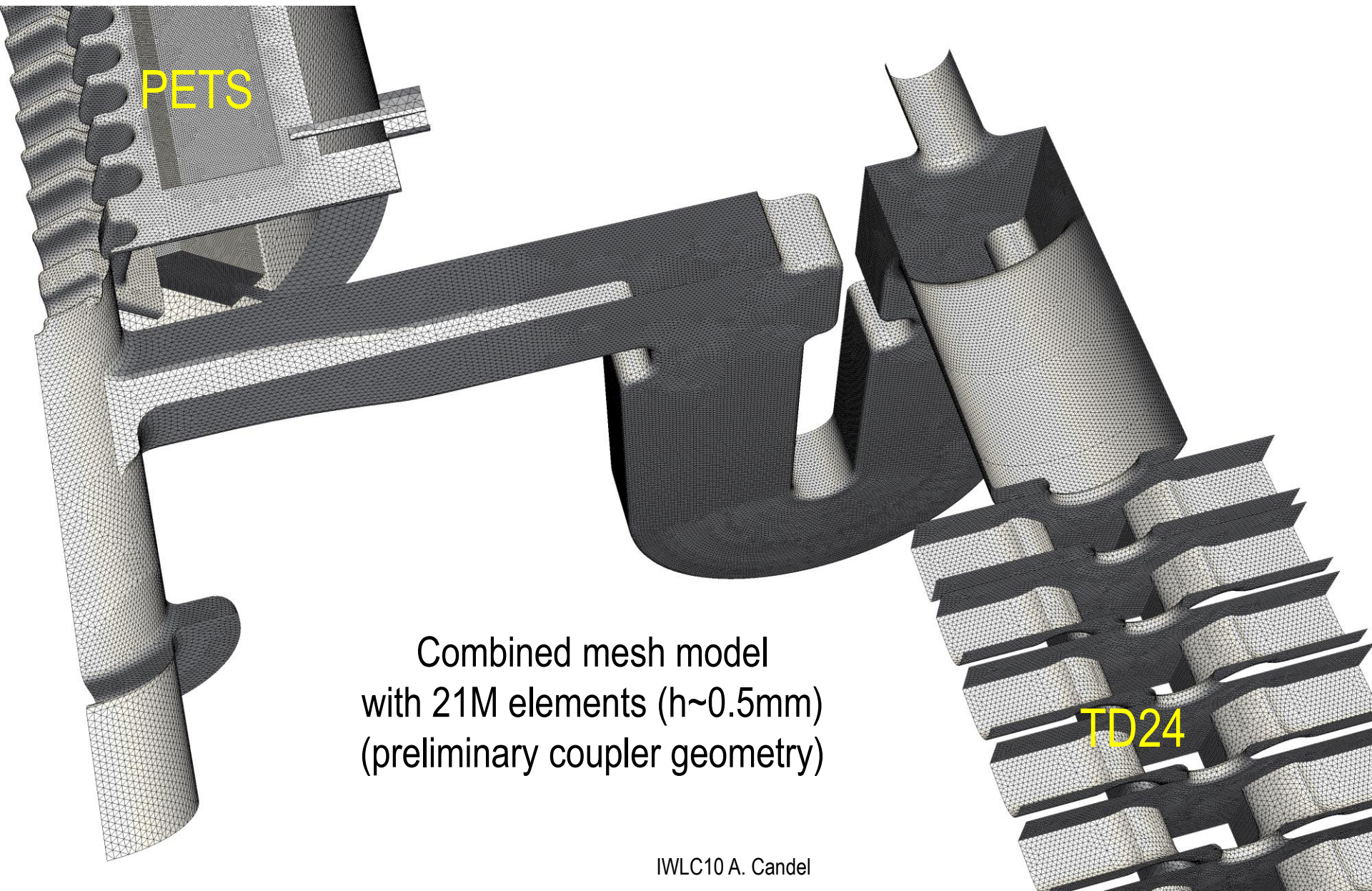
GENEVA  
1987

## CLIC two-beam in numbers

	PETS	Accelerating structure
Aperture radius [mm]	11.5	3.15-2.35
$R'/Q$ [k $\Omega$ /m]	2.2	15-18
$v_g/c$	0.49	0.0165-0.0083
Gradient [MV/m]	-6.3	+100



# T3P: Wakefield Coupling PETS $\leftrightarrow$ TD24

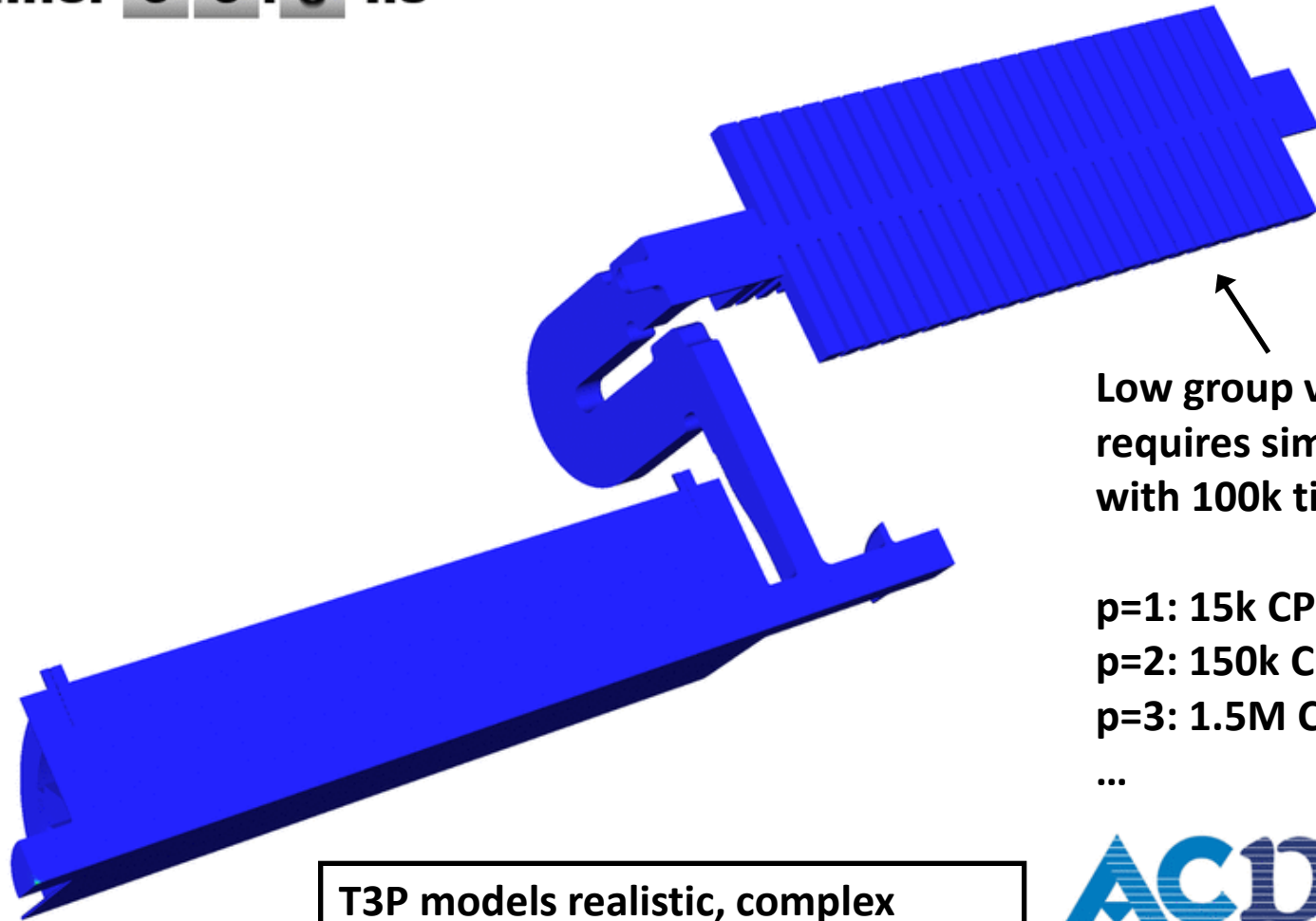


Combined mesh model  
with 21M elements ( $h \sim 0.5\text{mm}$ )  
(preliminary coupler geometry)



# ... and Simulation of RF power transfer

time: 0 0 . 0 ns



Low group velocity  
requires simulations  
with 100k time steps

p=1: 15k CPU hours  
p=2: 150k CPU hours  
p=3: 1.5M CPU hours

...

T3P models realistic, complex  
accelerator structures with  
unprecedented accuracy





# PETS – specifications



## High-power:

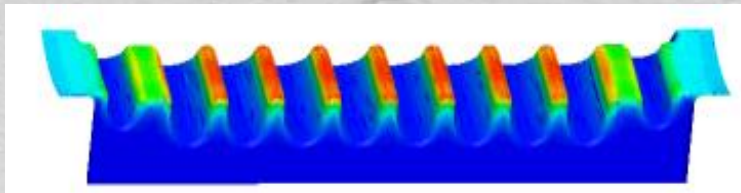
1. 135 MW output power
2. 170 (flat top)/240 (full) ns pulse length
3.  $<2 \times 10^{-7}$  1/pulse/m breakdown rate

## Beam dynamics:

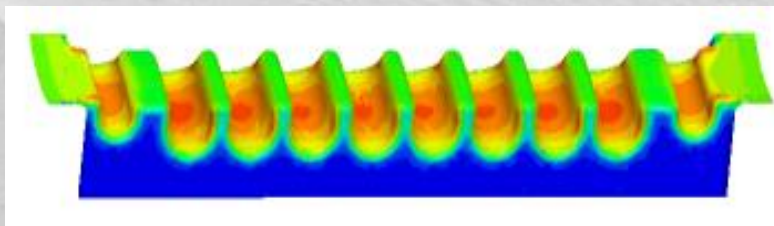
1. Fundamental mode: gives 23 mm diameter aperture which corresponds to  $a/\lambda=0.46$  and  $v_g/c=0.49$  to give 2.2 k $\Omega$ /m, longitudinal impedance
2. Single bunch transverse wake:  $< 8$  V/pC/mm/m
3. Long-range transverse wakefield with effective suppression of main HOMs by  $Q_n(1-\beta_n)<8$  each

## PETS parameters

Aperture, mm	23
Iris thickness, mm	2.0
Cell length, mm	6.253
Phase advance/cell, degrees	90
Corrugation depth, mm	4.283
R/Q, Ohm/m	2290
$\beta=V_g/c$	0.453
Q-factor	7200
Active length, m	0.213 (34 cells)
RF pulse length, ns	241
Drive Beam current, A	101
Output RF power, MW	133.7
Peak surface electric field, MV/m	56
Peak surface magnetic field, MA/m	0.08
Pulsed temperature rise, °C	1.8
Breakdown trip rate, 1/pulse/meter	$1 \times 10^{-7}$



Surface electric field



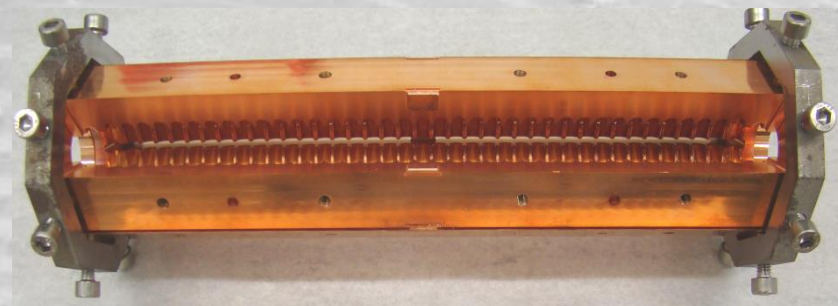
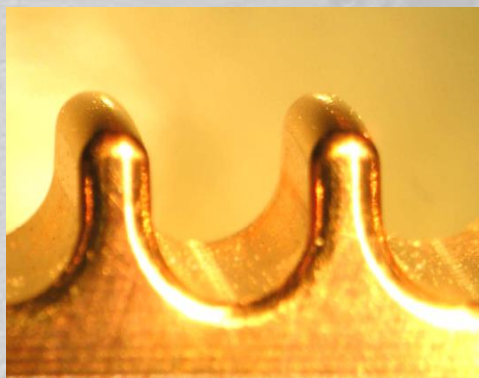
Surface magnetic field

Beam-driven structure so power rises quadratically with current and length,

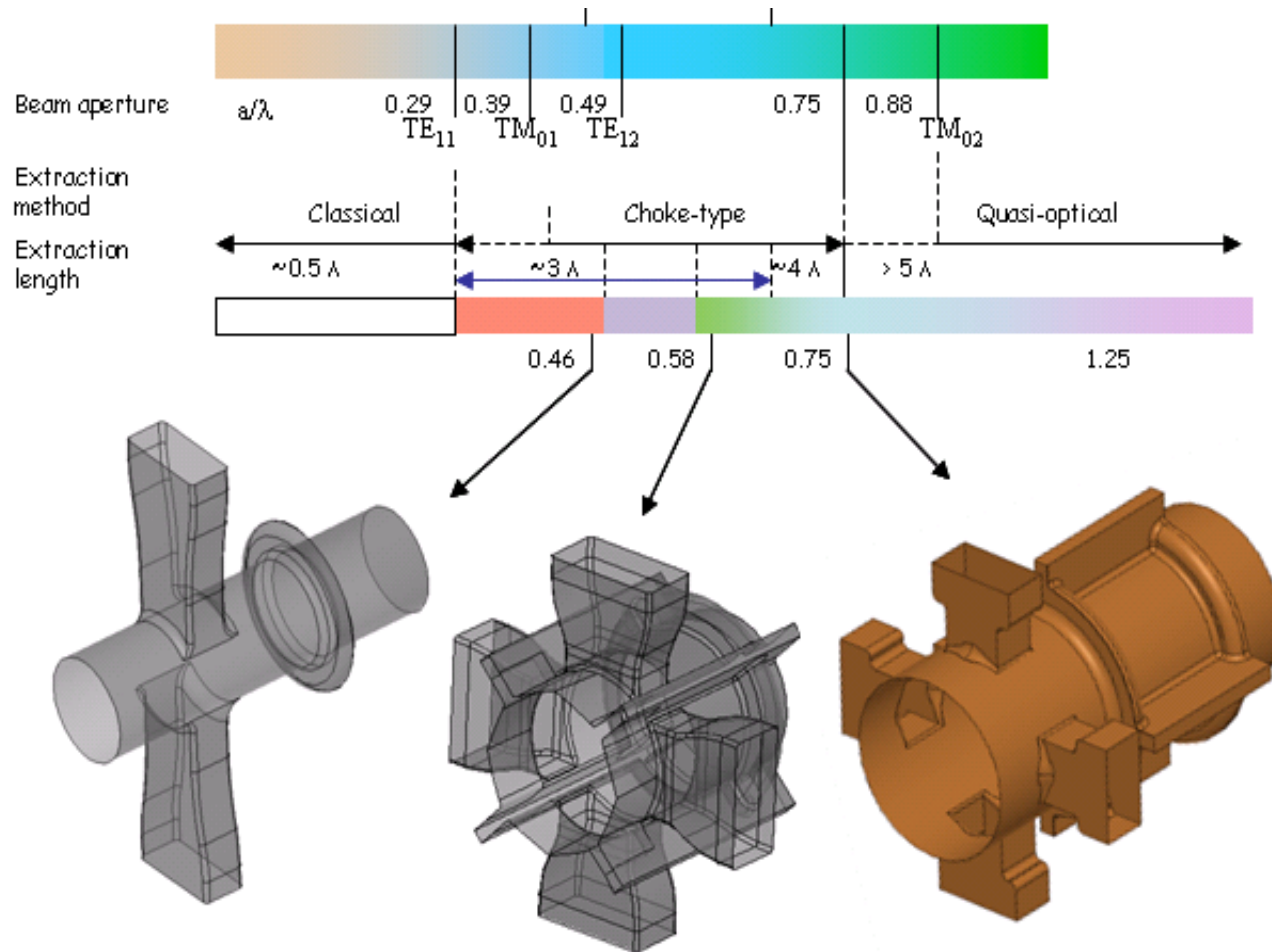
- 135 MW for 100 A beam
- 213 mm active length

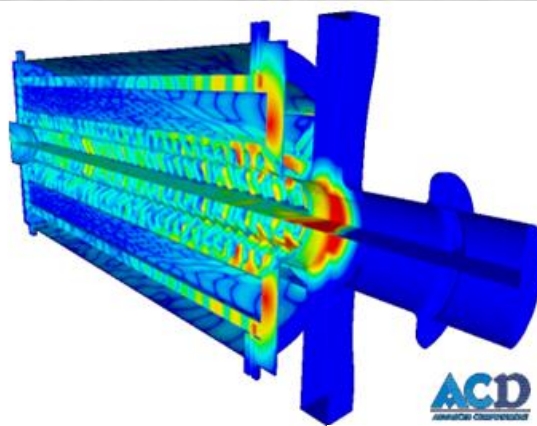
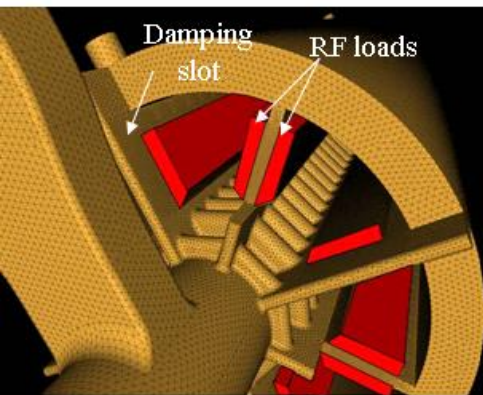
Maximum fields at output with values,

- $E_{\text{surf}}=56$  MV/m
- $\Delta T=1.8$  ( $H_{\text{surf}}=0.08$  MA/m)
- $S_c=1.2$  MW/mm<sup>2</sup>



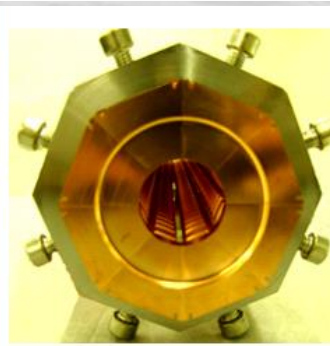
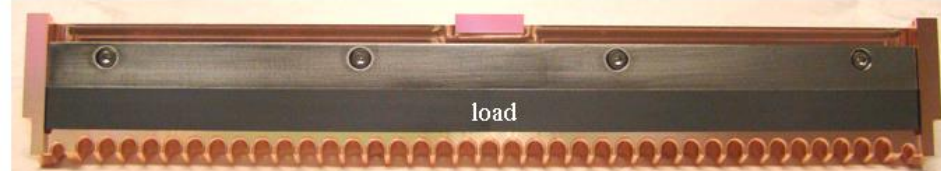
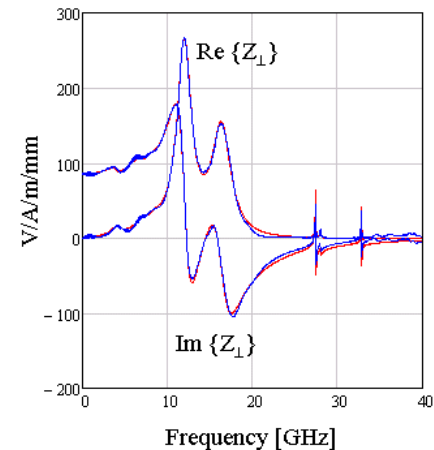
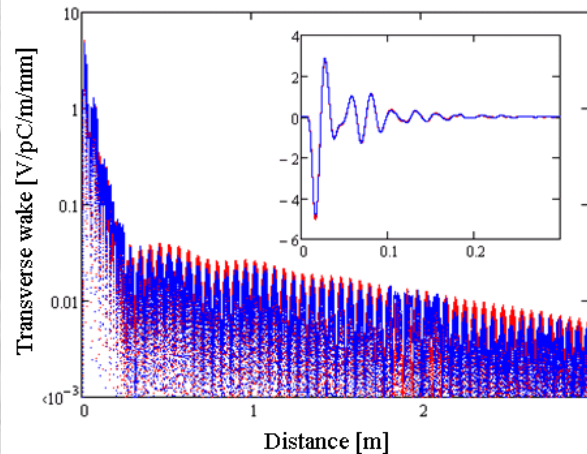
# Overmoded couplers for PETS





ACE3P analysis of HOM properties

GdfidL and ACE3P benchmarking with analysis of PETS HOM properties



PETS for high-power testing with SiC absorbers installed.

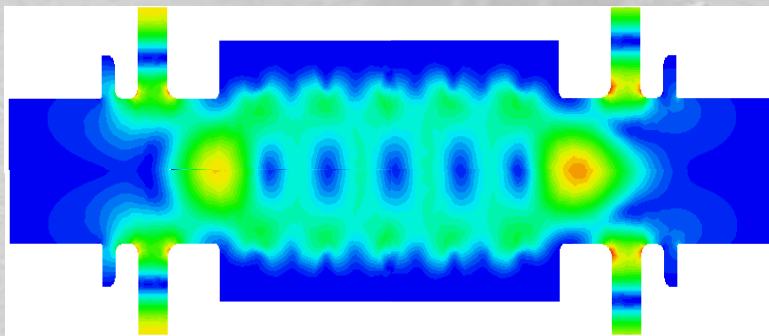
To high-power test the PETS in nominal conditions would require a 100 A driving beam.

**“Waveguide” test** with klystron/pulse compressor

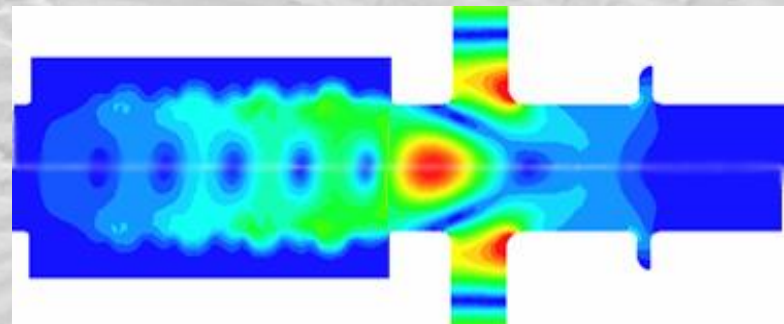
- not many 135+ MW X-band power sources – ASTA at SLAC
- much harder to run, full fields at input

**Beam-based tests** with CTF3 4-30 A beam.

- 1000 mm long PETS
- Connect output to input – beam-driven rf resonant ring for lower, <10 A, current



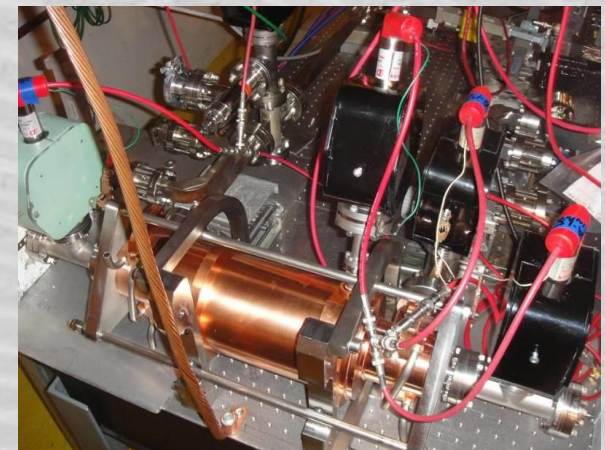
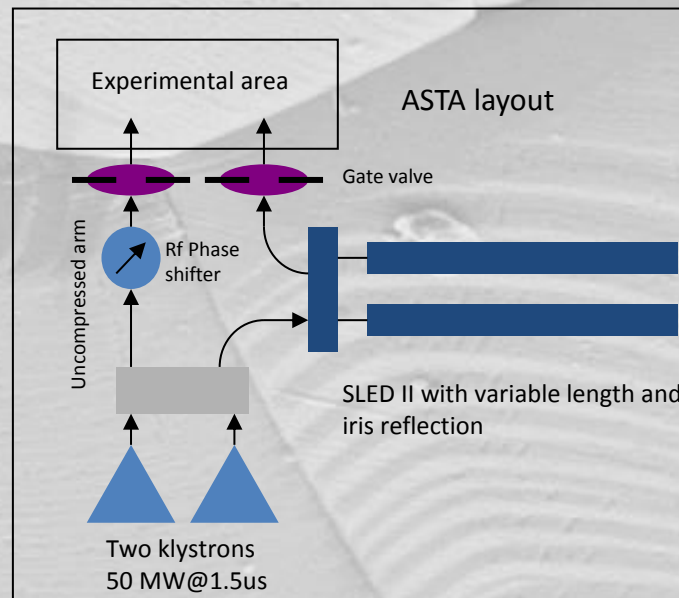
Fields in klystron and recirculation tests



Fields in CLIC and CTF3 at high current

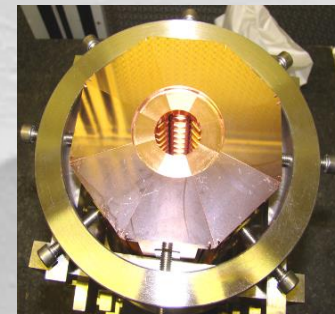
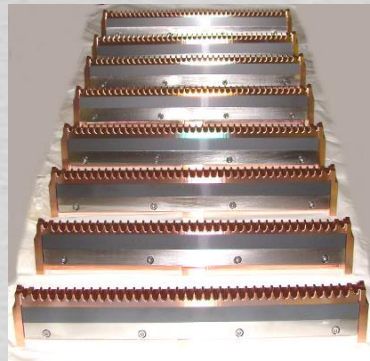
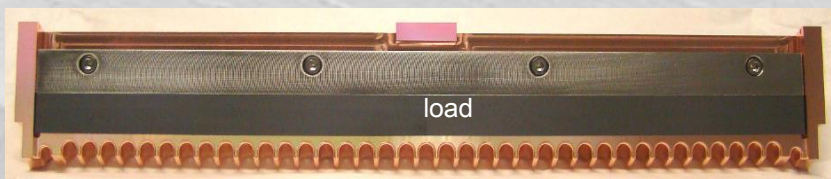
# PETS testing in ASTA

PETS waveguide-mode PETS testing is being done at ASTA in SLAC an impressive facility but testing a single object with 135+ MW power is very challenging. The results you will see are a mixture of conditioning of the PETS and ASTA...

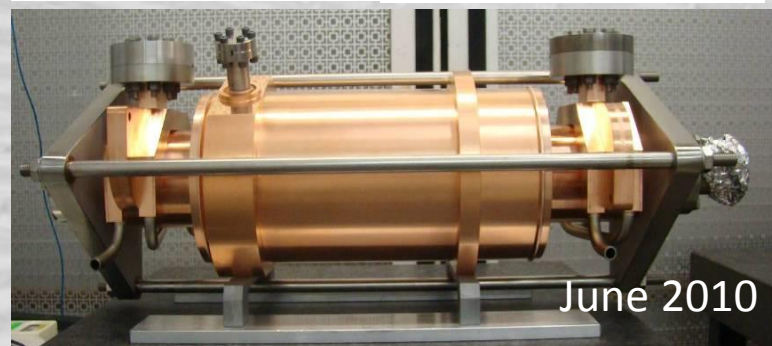
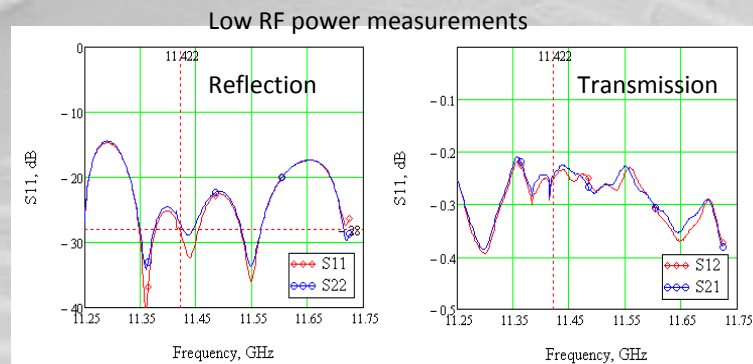
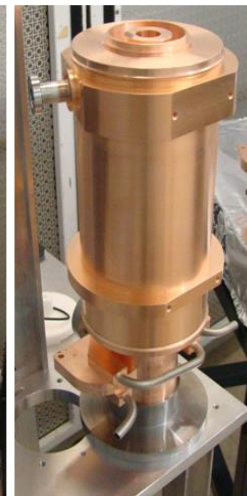
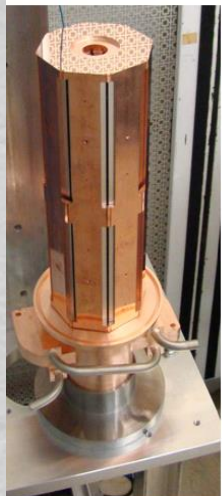
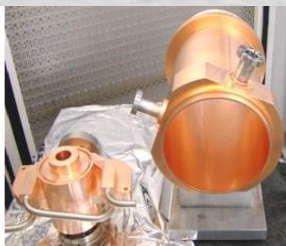




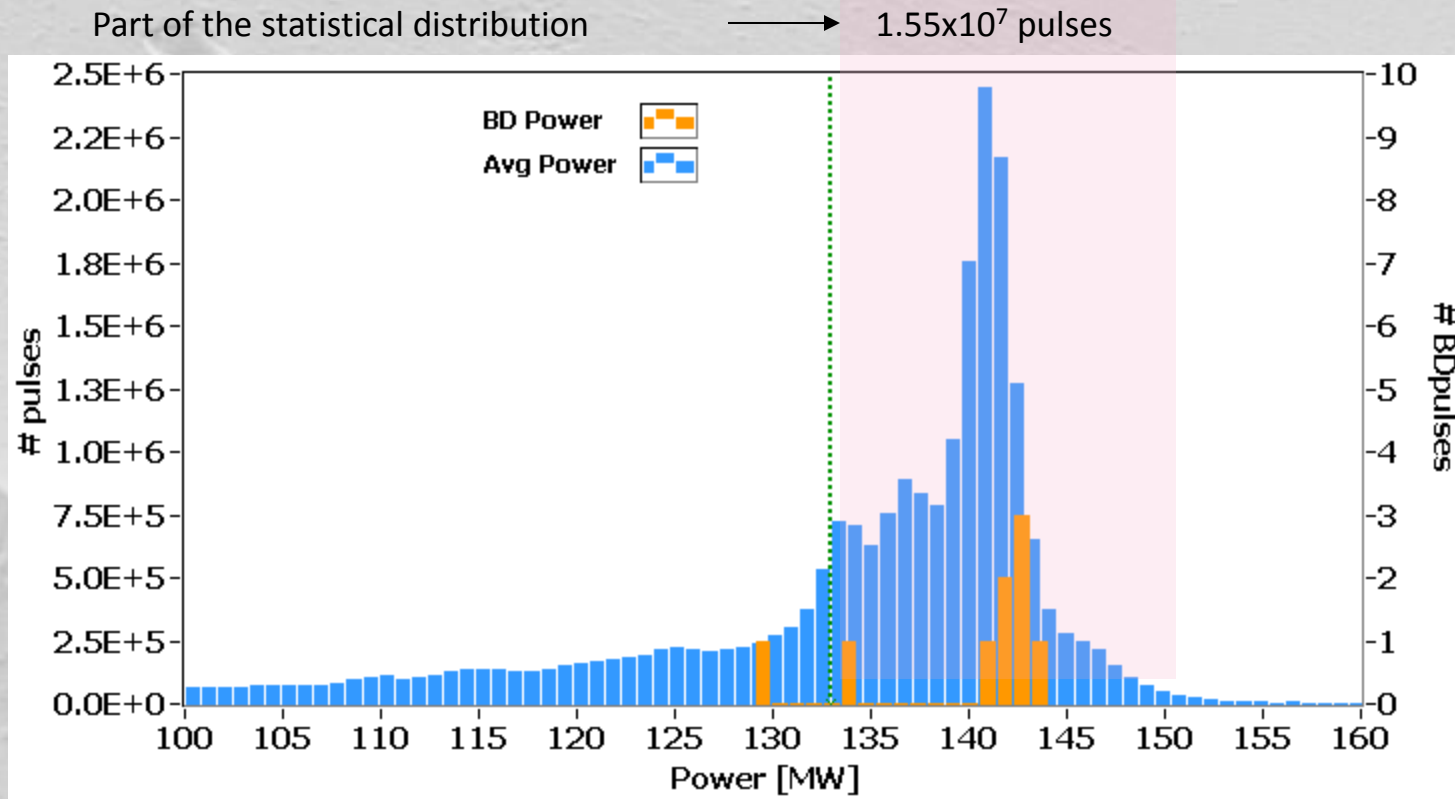
# ASTA test PETS version with damping slots and damping material (SiC)



PETS preparation for the EB welding of the RF couplers and the mini-tank



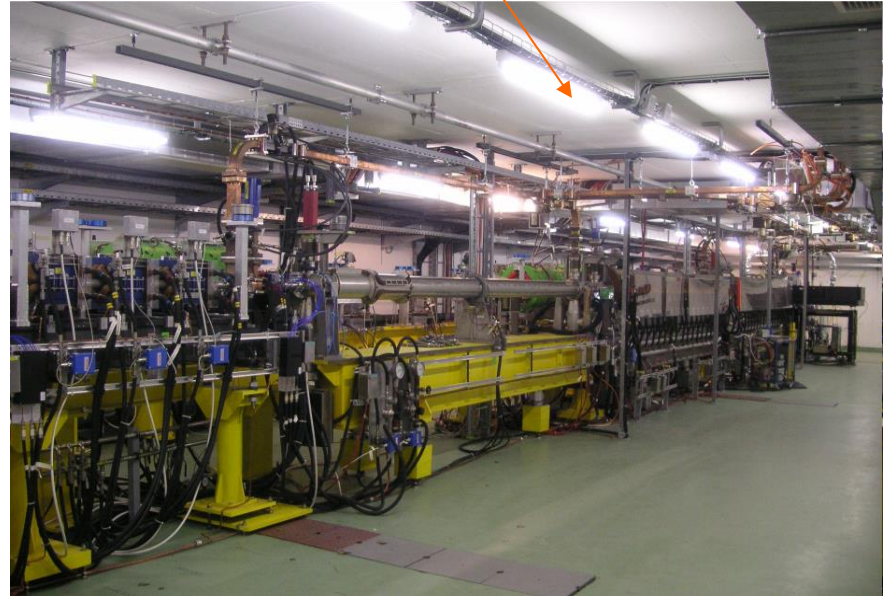
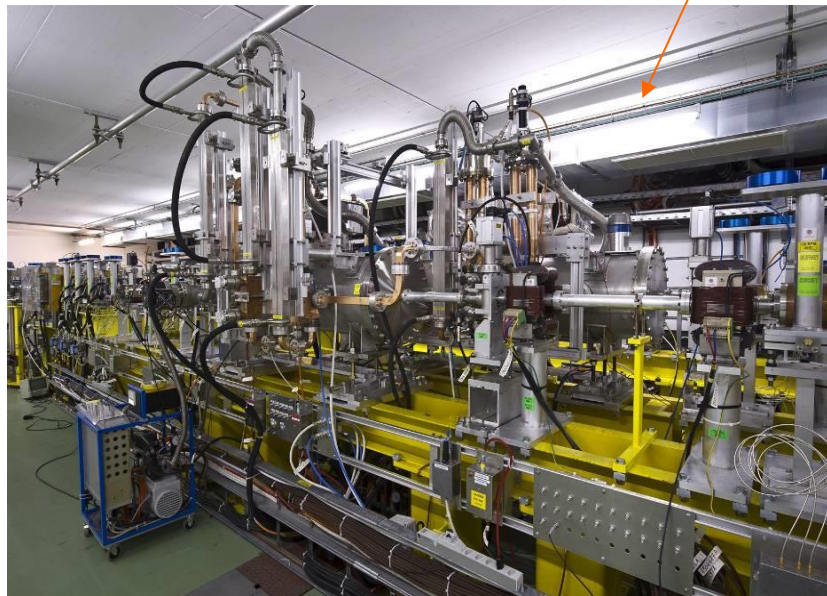
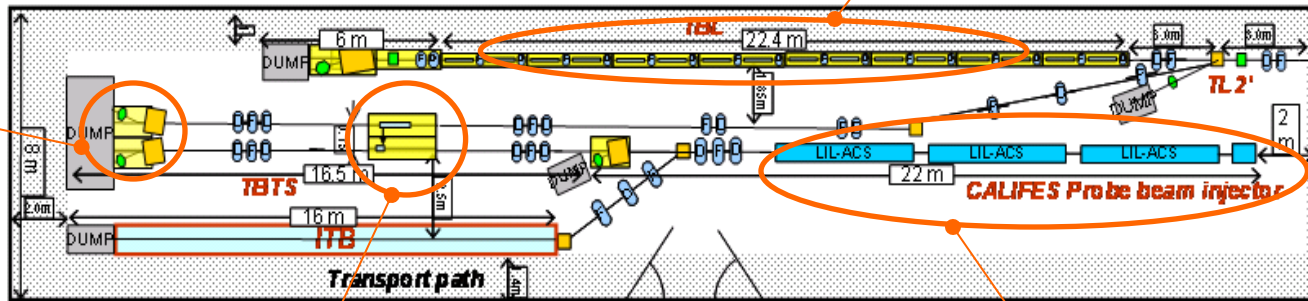
June 2010



- $1.55 \times 10^7$  pulses were accumulated in a 125 hour run.
- 8 PETS breakdowns were identified giving a breakdown rate of  $5.3 \times 10^{-7}$ /pulse.
- Most of the breakdowns were located in the upper tail of the distribution, which makes BDR estimate rather conservative.
- During the last 80 hours no breakdowns were registered giving a BDR  $< 1.2 \times 10^{-7}$ /pulse.

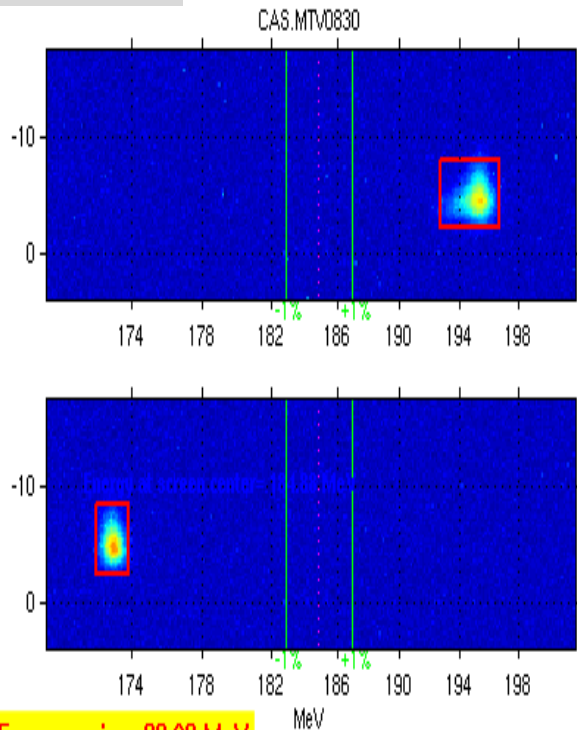


TBTS is the test area in CLEX, where feasibility of the CLIC two beam acceleration scheme is...already demonstrated (not yet at a nominal 100 MV/m accelerating gradient).

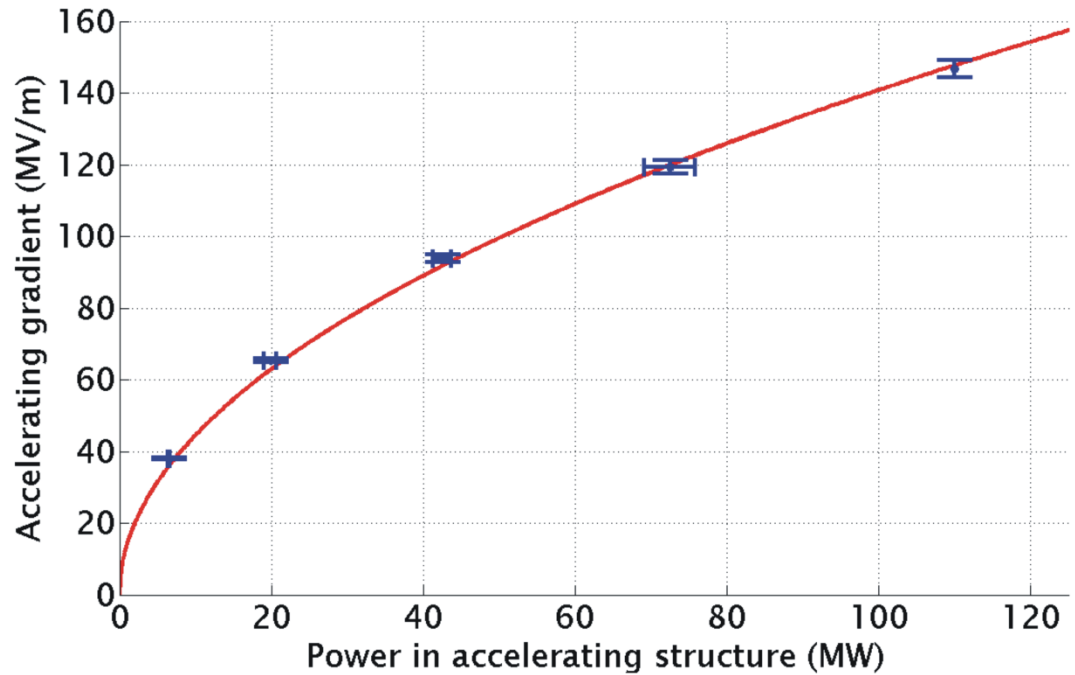


# TBTS: Two Beam Acceleration

CTF3 team



Energy gain = 23.08 MeV



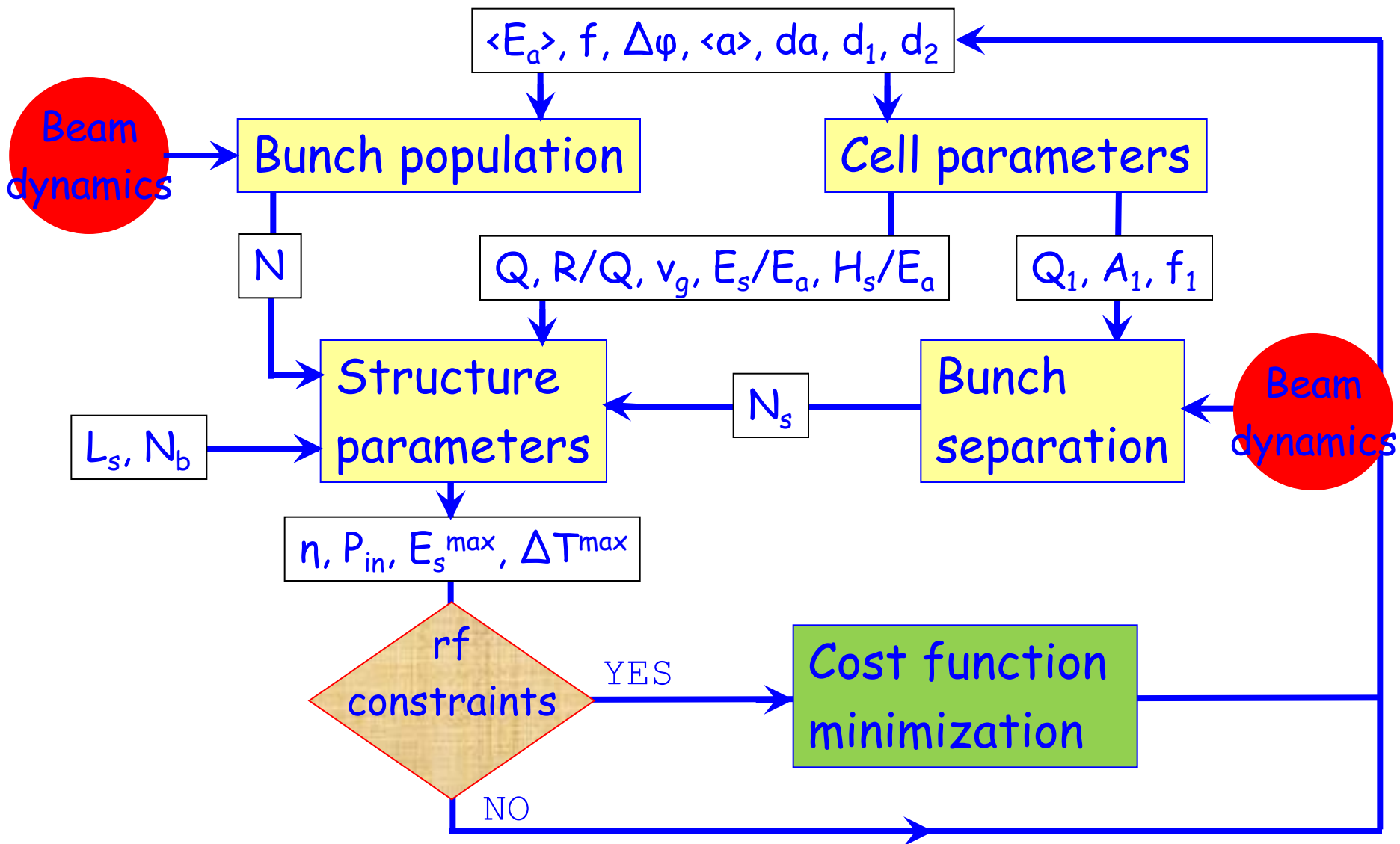
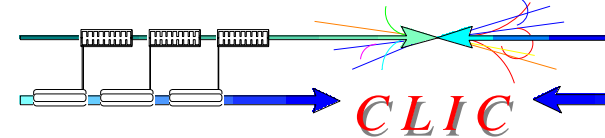
Maximum gradient  
145 MV/m



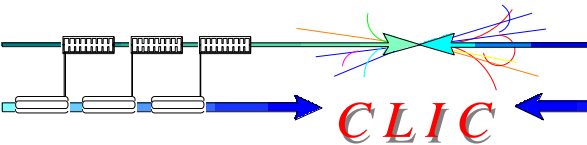
Consistency between

- produced power
- drive beam current
- test beam acceleration

# Optimization procedure



# Beam dynamics input



$$FoM = L_{bx} / N \cdot n$$

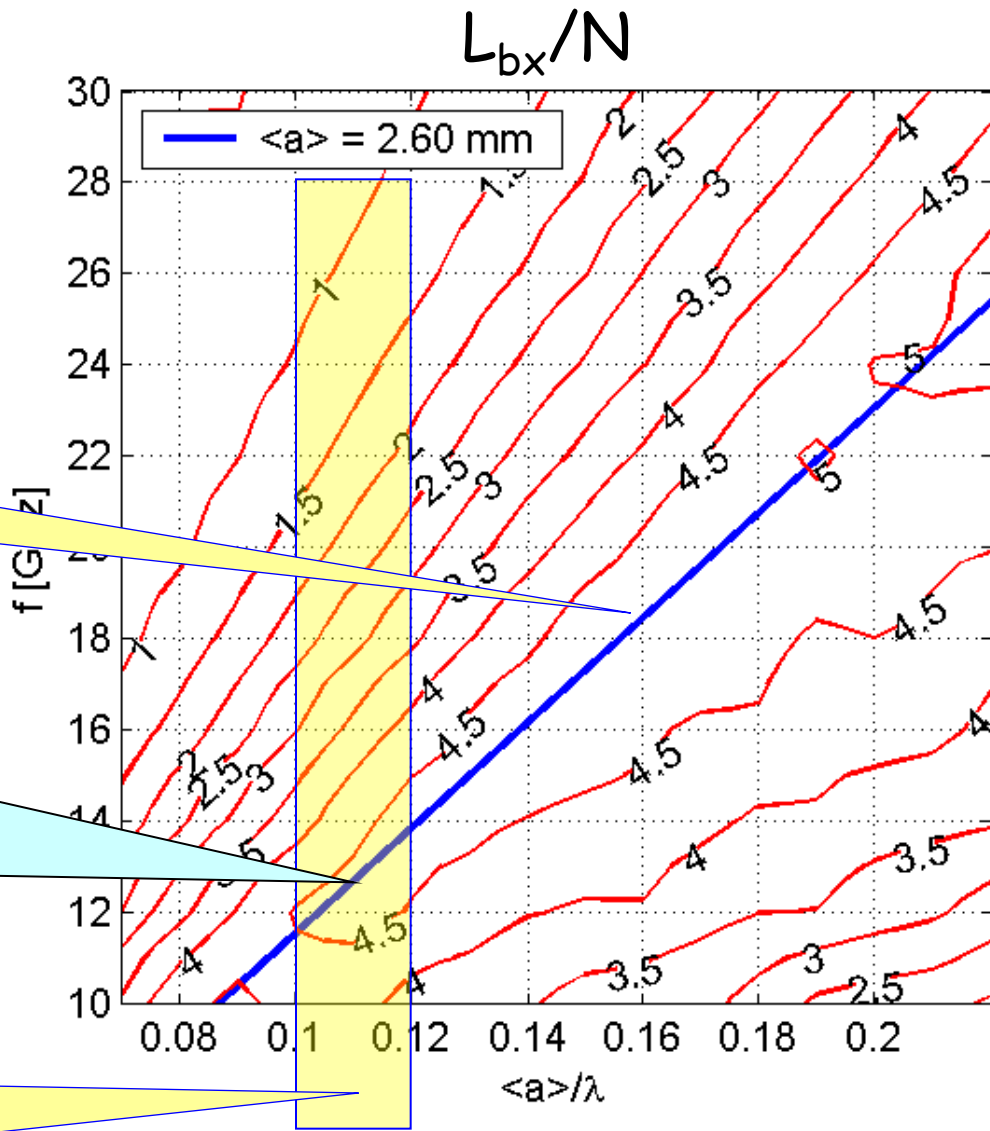
BD

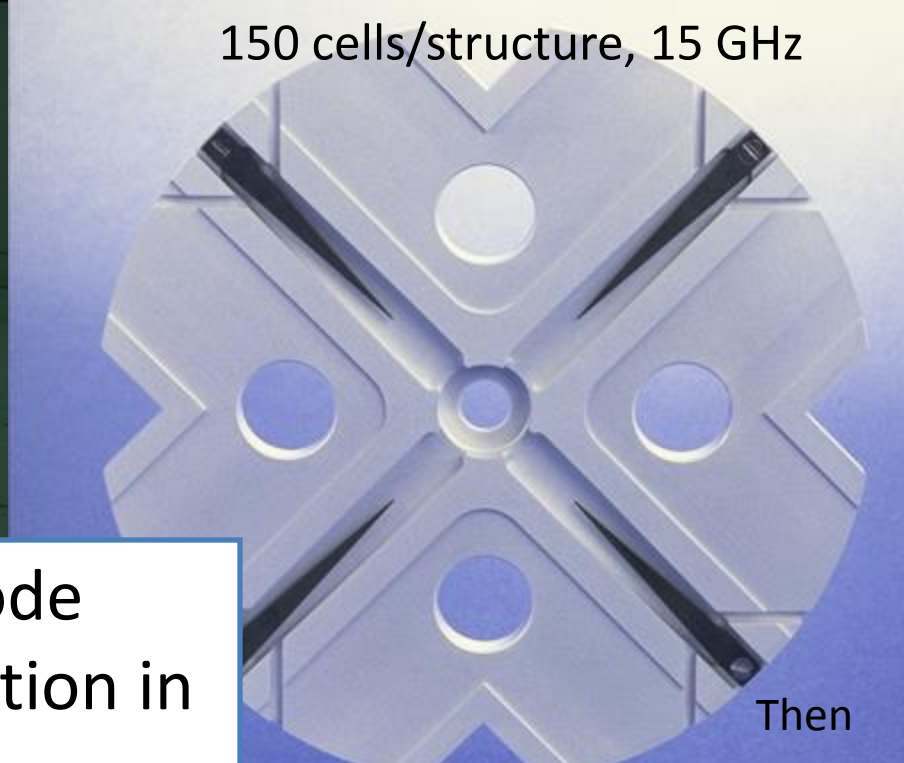
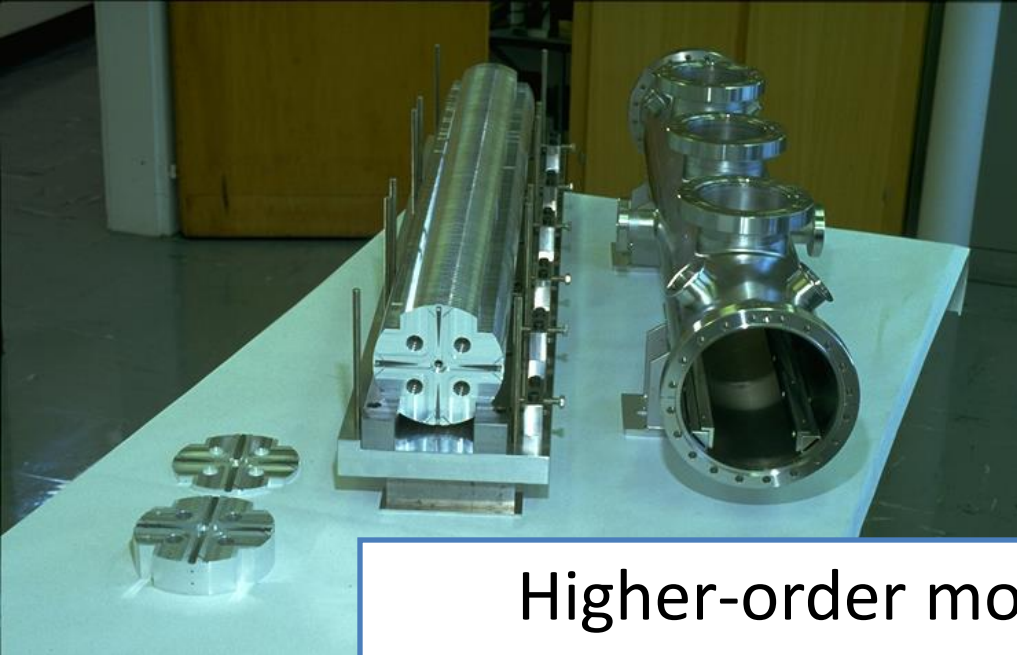
RF

BD optimum aperture:  
 $\langle a \rangle = 2.6 \text{ mm}$

**Why X-band ?**  
Crossing gives optimum frequency

High-power RF optimum aperture:  
 $\langle a \rangle / \lambda = 0.1 \div 0.12$

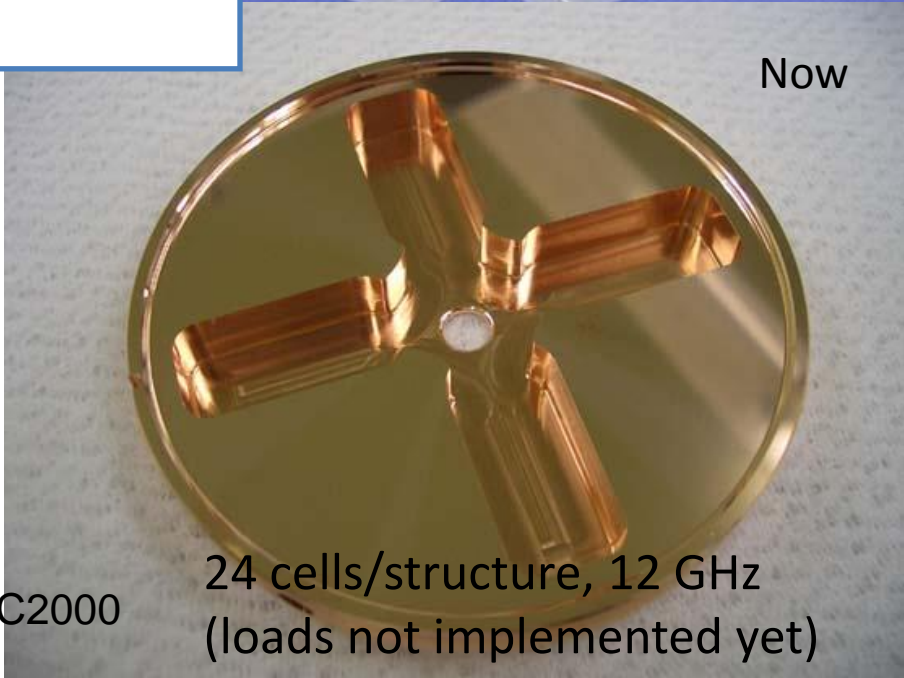
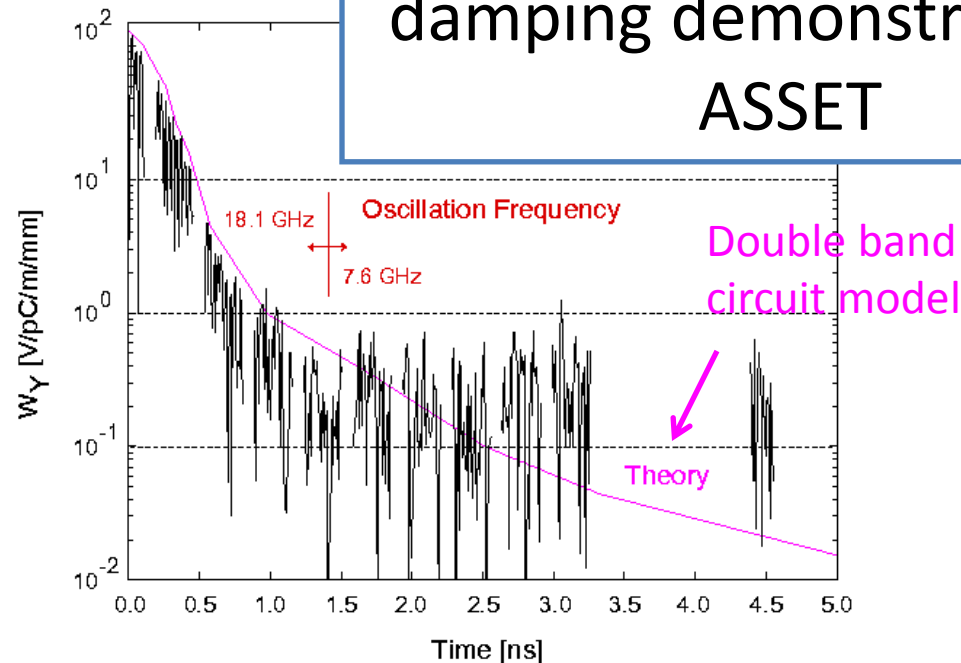




150 cells/structure, 15 GHz

Then

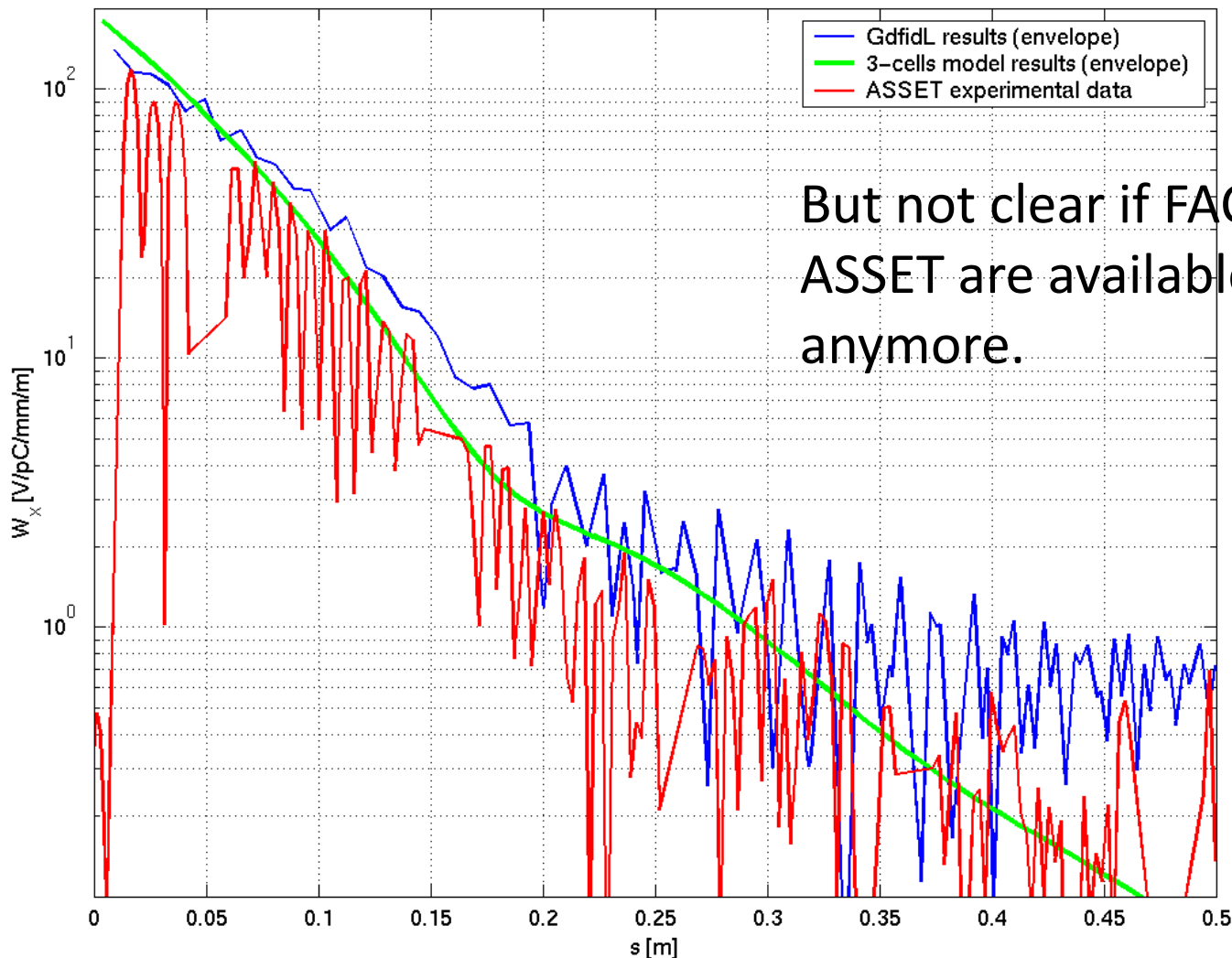
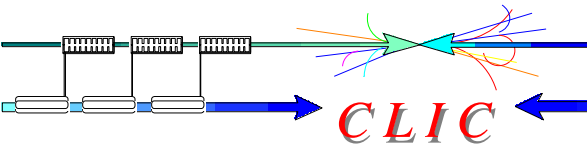
# Higher-order mode damping demonstration in ASSET



Now

24 cells/structure, 12 GHz  
(loads not implemented yet)

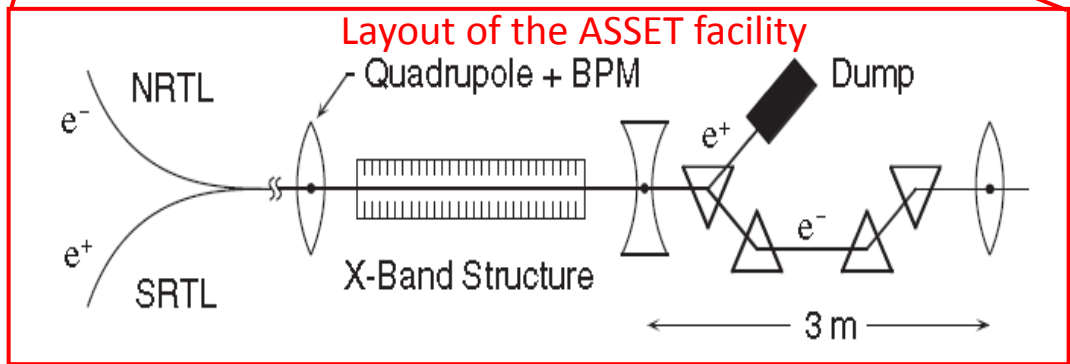
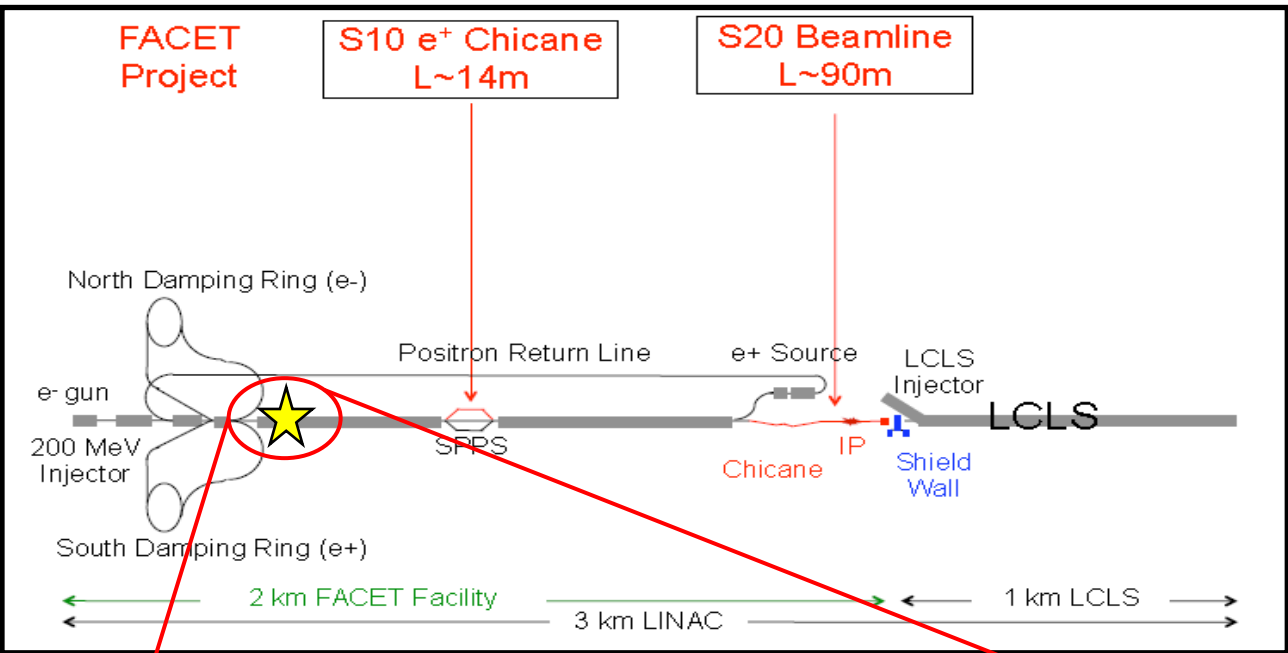
# Full length TDS results comparison



But not clear if FACET or ASSET are available anymore.



# Ready for another try in the FACET facility at SLAC.





# The CLIC Layout

